

# Dell PowerEdge R760xs

## Technical Guide

## Notes, cautions, and warnings

 **NOTE:** A NOTE indicates important information that helps you make better use of your product.

 **CAUTION:** A CAUTION indicates either potential damage to hardware or loss of data and tells you how to avoid the problem.

 **WARNING:** A WARNING indicates a potential for property damage, personal injury, or death.

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# System overview

The Dell PowerEdge R760xs is Dell's latest two-socket, rack server that is designed to run complex workloads using highly scalable memory, I/O, and network options. The systems feature the 4<sup>th</sup> and 5<sup>th</sup> Gen Intel® Xeon® Scalable Processor (Socket E1/LGA4677-1), up to 16 DIMMs, PCI Express® (PCIe) 5.0 enabled expansion slots, and a broad selection of network interface technologies.

## Topics:

- [Key workloads](#)
- [New technologies](#)

## Key workloads

The target workloads for the PowerEdge R760xs include virtualization, medium density VM and VDI, and scale-out database.

## New technologies

**Table 1. New technologies**

Technology	Detailed Description
Up to 2 x 5th Gen Intel(R) Xeon(R) Scalable Processors (Emerald Rapids)	Core count: Up to 28 per processor Up to 3.9 GHz UPI speed: Up to 3x UPIs/Socket at 12.8 GT/s or 14.4 or 16 GT/s or 20 GT/s Maximum number of PCIe lanes: Integrated 80 PCIe 5.0 lanes @ 32 GT/s PCIe Gen5 Maximum TDP: 250 W
Up to 2 x 4th Gen Intel(R) Xeon(R) Scalable Processors (Sapphire Rapids)	Core count: Up to 32 per processor UPI speed: Up to 3x UPIs/Socket at 12.8 GT/s or 14.4 or 16 GT/s Maximum number of PCIe lanes: Integrated 80 PCIe 5.0 lanes @ 32 GT/s PCIe Gen5 Maximum TDP: 250 W
DDR5 ECC memory up to 5200 MT/s	Max 8 DIMMs per processor and 16 DIMMs per system
	Supports DDR5 ECC RDIMM
GPUs	Max 2 x 75 W SW GPUs (NVIDIA A2)
Flex I/O	LOM: 2x1GbE with BCM5720 LAN controller
	Rear I/O with: <ul style="list-style-type: none"> <li>• 1x Dedicated iDRAC Ethernet port (1 GbE)</li> <li>• 1 x USB 3.0</li> <li>• 1 x USB 2.0</li> <li>• 1 x VGA port</li> </ul>

**Table 1. New technologies (continued)**

Technology	Detailed Description
	Serial Port option Optional OCP Mezz 3.0 (supported by x8 PCIe lanes) Front I/O with: <ul style="list-style-type: none"> <li>● 1 x USB 2.0</li> <li>● 1x iDRAC Direct (Micro-AB USB) port</li> <li>● 1 x VGA port</li> </ul>
CPLD 1-wire	Support payload data of Front PERC, Riser, BP and Rear IO to BOSS-N1 and iDRAC
Dedicated PERC	Front Storage module PERC with Front PERC11, PERC12 and PERC 12.2
Software RAID	OS RAID / S160
Power Supplies	60 mm dimension is the new PSU form factor on 16G design <ul style="list-style-type: none"> <li>● 600 W Platinum 100–240 VAC/ 240 VDC</li> <li>● 700 W Titanium 200–240 VAC/240 VDC</li> <li>● 800 W Platinum 100–240 VAC/ 240 VDC</li> <li>● 1100 W DC/-48–(-60) V</li> <li>● 1100 W Titanium 100–240 VAC/ 240 VDC</li> <li>● 1400 W Titanium 100–240 VAC/ 240 VDC</li> <li>● 1400 W Platinum 100–240 VAC/ 240 VDC</li> <li>● 1400 W Titanium 277 VAC/ 336 VDC</li> <li>● 1800 W Titanium 200–240 VAC/ 240 VDC</li> </ul>

## System features and generational comparison

The following table shows the comparison between the PowerEdge R760xs with the PowerEdge R750xs.

**Table 2. Features comparison**

Feature	PowerEdge R760xs	PowerEdge R750xs
Processor	<ul style="list-style-type: none"> <li>Up to 2 x 4th Gen Intel(R) Xeon(R) Scalable Processors (Sapphire Rapids) with up to 32 cores</li> <li>Up to 2 x 5th Gen Intel(R) Xeon(R) Scalable Processors (Emerald Rapids) with up to 28 cores</li> </ul>	Maximum two 3 <sup>rd</sup> Generation Intel® Xeon® Scalable processors with maximum 32 cores per processor
Processor Interconnect	Intel Ultra Path Interconnect (UPI) , up to 3 links per CPU	Intel Ultra Path Interconnect (UPI)
Memory	16 DDR5 DIMM slots Supports RDIMM 1.5 TB max Speed maximum 5200 MT/s for 5th generation and 4800 MT/s for 4th generation processors Supports registered ECC DDR5 DIMMs only NVDIMM : No	16 DDR4 DIMM slots Supports RDIMM 1 TB max Speed maximum 3200 MT/s Supports registered ECC DDR4 DIMMs only Apache Pass : No NVDIMM : No
Storage Drives	Front bays: <ul style="list-style-type: none"> <li>0 drive bay</li> <li>Maximum 8x 3.5-inch SAS/SATA (HDD/SSD) max 192 TB</li> <li>Maximum 12x 3.5-inch SAS/SATA (HDD/SSD) max 288 TB</li> <li>Maximum 8x 2.5-inch SAS/SATA/NVMe (HDD/SSD) max 122.88 TB</li> <li>Maximum 16x 2.5-inch SAS/SATA (HDD/SSD) max 121.6 TB</li> <li>Maximum 16x 2.5-inch (SAS/SATA) + 8x 2.5-inch (NVMe) (HDD/SSD) max 244.48 TB</li> </ul>	Front bays: <ul style="list-style-type: none"> <li>0 drive bay</li> <li>Maximum 8x 3.5-inch SAS/SATA (HDD/SSD) max 128 TB</li> <li>Maximum 12x 3.5-inch SAS/SATA (HDD/SSD) maximum 192 TB</li> <li>Maximum 8x 2.5-inch SAS/SATA/NVMe (HDD/SSD) maximum 61.44 TB</li> <li>Maximum 16x 2.5-inch SAS/SATA (HDD/SSD) maximum 122.88 TB</li> <li>Maximum 16x 2.5-inch (SAS/SATA) + 8x 2.5-inch (NVMe) (HDD/SSD) maximum 184.32 TB</li> </ul>
	Rear bays: <ul style="list-style-type: none"> <li>Maximum 2x 2.5-inch SAS/SATA/NVMe (HDD/SSD) max 30.72 TB</li> </ul>	Rear bays: <ul style="list-style-type: none"> <li>Maximum 2x 2.5-inch SAS/SATA/NVMe (HDD/SSD) maximum 15.36 TB</li> </ul>
Storage Controllers	Internal controllers: H965i, HBA465i, H755, H755N, H355, HBA355i Internal Boot: Boot Optimized Storage Subsystem (BOSS N1): HWRAID 2x M.2 SSDs and Internal USB External: HBA355e, H965e Software RAID: S160	Internal controllers: PERC H345, PERC H355, PERC H745, PERC H755, PERC H755N, HBA355i Internal Boot: Internal Dual SD Module or Boot Optimized Storage Subsystem (BOSS S2): HWRAID 2x M.2 SSDs or Internal USB External PERC (RAID): PERC H840, HBA355e Software RAID: S150

**Table 2. Features comparison (continued)**

<b>Feature</b>	<b>PowerEdge R760xs</b>	<b>PowerEdge R750xs</b>
PCIe SSD	Front: Maximum 8 x 2.5-inch (NVMe drives)	Maximum 8 x 2.5-inch (NVMe drives)
	Rear: Up to 2 x 2.5-inch NVMe	
PCIe Slots	Up to 6 PCIe slots (2 x Gen5, 4 x Gen4)	Up to 6 PCIe slots (5 x Gen4, 1 x Gen3)
Embedded NIC (LOM)	2x 1GbE LOM	2x 1GbE LOM
Networking Options (OCP 3.0)	Rear: 1 x OCP 3.0 (x8 PCIe lanes)	Maximum 1 OCP 3.0 (x16 PCIe lanes)
GPU	Nvidia A2 (60 W, LP)	Not supported
I/O Ports	Front ports <ul style="list-style-type: none"> <li>• 1x Dedicated iDRAC micro-USB</li> <li>• 1x USB 2.0</li> <li>• 1x VGA</li> </ul>	Front ports <ul style="list-style-type: none"> <li>• 1x Dedicated iDRAC micro-USB</li> <li>• 1x USB 2.0</li> <li>• 1x VGA</li> </ul>
	Rear ports: <ul style="list-style-type: none"> <li>• 1 x Dedicated iDRAC Ethernet port</li> <li>• 1x USB 2.0</li> <li>• 1x USB 3.0</li> <li>• 1x Serial (optional)</li> <li>• 1x VGA</li> <li>• 2x Ethernet</li> </ul>	Rear ports: <ul style="list-style-type: none"> <li>• 1 x Dedicated iDRAC Ethernet port</li> <li>• 1x USB 2.0</li> <li>• 1x USB 3.0</li> <li>• 1x Serial (optional)</li> <li>• 1x VGA</li> <li>• 2x Ethernet</li> </ul>
	Internal port: <ul style="list-style-type: none"> <li>• 1x USB 3.0 (optional)</li> </ul>	Internal port: <ul style="list-style-type: none"> <li>• 1x USB 3.0 (optional)</li> </ul>
Rack Height	2U rack server	2U rack server
Power Supplies	<ul style="list-style-type: none"> <li>• 1800 W Titanium 200–240 VAC/ 240 VDC</li> <li>• 1400 W Titanium 100–240 VAC/ 240 VDC</li> <li>• 1400 W Platinum 100–240 VAC/ 240 VDC</li> <li>• 1400 W Titanium 277 VAC/ 336 VDC</li> <li>• 1100 W Titanium 100–240 VAC/ 240 VDC</li> <li>• 1100 W DC/-48–(-60) V</li> <li>• 800 W Platinum 100–240 VAC/ 240 VDC</li> <li>• 700 W Titanium 200–240 VAC/240 VDC</li> <li>• 600 W Platinum 100–240 VAC/ 240 VDC</li> </ul>	<ul style="list-style-type: none"> <li>• 1800 W Platinum 100–240 VAC/ 240 VDC</li> <li>• 1400 W Platinum 100–240 VAC/ 240 VDC</li> <li>• 1100 W Titanium 100–240 VAC/ 240 VDC</li> <li>• 1100 W DC/-48–(-60) V</li> <li>• 800 W Platinum 100–240 VAC/ 240 VDC</li> <li>• 700 W Titanium 200–240 VAC/240 VDC</li> <li>• 600 W Platinum 100–240 VAC/ 240 VDC</li> </ul>
System Management	<ul style="list-style-type: none"> <li>• Lifecycle Controller 3.x</li> <li>• OpenManage</li> <li>• QuickSync 2.0</li> <li>• OpenManage Enterprise Power Manager</li> <li>• Digital License Key</li> <li>• iDRAC Direct (dedicated micro-USB port)</li> <li>• Easy Restore</li> </ul>	<ul style="list-style-type: none"> <li>• Lifecycle Controller 3.x</li> <li>• OpenManage</li> <li>• QuickSync 2.0</li> <li>• OpenManage Enterprise Power Manager</li> <li>• Digital License Key</li> <li>• iDRAC Direct (dedicated micro-USB port)</li> <li>• Easy Restore</li> </ul>
Availability	<p>Hot-plug drives</p> <p>Hot-plug redundant cooling</p> <p>Hot-plug redundant power supplies</p> <p>BOSS-N1</p>	<p>Hot-plug drives</p> <p>Hot-plug redundant cooling</p> <p>Hot-plug redundant power supplies</p> <p>IDSDM</p> <p>BOSS S2</p>

# Chassis views and features

## Topics:

- Chassis views

## Chassis views

### Front view of the system



Figure 1. Front view of 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe drive system



Figure 2. Front view of 16 x 2.5-inch SAS/SATA drive system

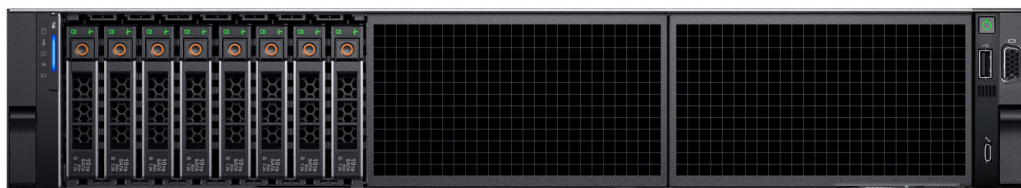


Figure 3. Front view of 8 x 2.5-inch SAS/SATA or NVMe drive system



Figure 4. Front view of 12 x 3.5-inch SAS/SATA drive system



Figure 5. Front view of 8 x 3.5-inch SAS/SATA drive system

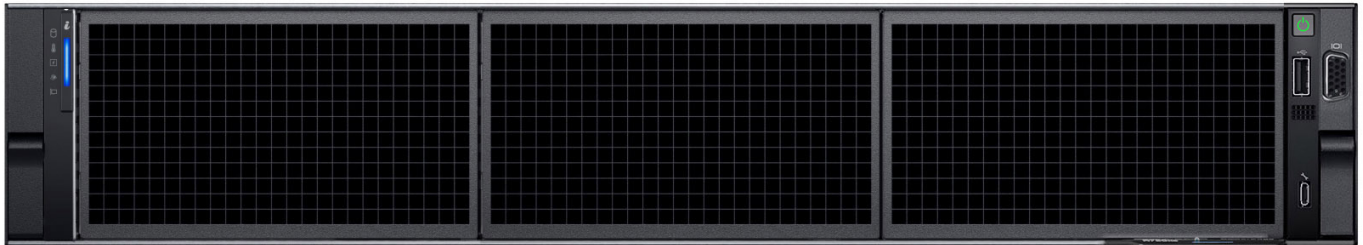


Figure 6. Front view of no backplane configuration (0 drive system)

### Left control panel view

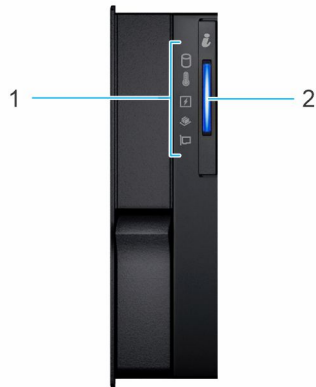



Figure 7. Left control panel

Table 3. Left control panel

Item	Indicator, button, or connector	Icon	Description
1	Status LED indicators	NA	Indicates the status of the system. For more information, see the <a href="#">Status LED indicators</a> section.
2	System health and system ID		Indicates the system health. For more information, see the <a href="#">System health and system ID indicator codes</a> section.

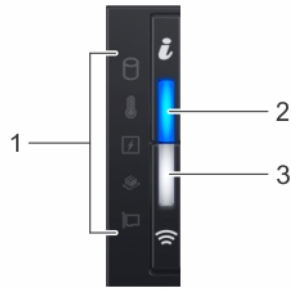


Figure 8. Left control panel with optional iDRAC Quick Sync 2 indicator

Table 4. Left control panel with optional iDRAC Quick Sync 2 indicator

Item	Indicator, button, or connector	Icon	Description
1	Status LED indicators	N/A	Indicates the status of the system. For more information, see the <a href="#">Status LED indicators</a> section.
2	System health and system ID indicator	<i>i</i>	Indicates the system health. For more information, see the <a href="#">System health and system ID indicator codes</a> section.
3	iDRAC Quick Sync 2 wireless indicator (optional)	☰	Indicates if the iDRAC Quick Sync 2 wireless option is activated. The Quick Sync 2 feature allows management of the system using mobile devices. This feature aggregates hardware/firmware inventory and various system level diagnostic/error information that can be used in troubleshooting the system. You can access system inventory, Dell Lifecycle Controller logs or system logs, system health status, and also configure iDRAC, BIOS, and networking parameters. You can also launch the virtual Keyboard, Video, and Mouse (KVM) viewer and virtual Kernel-based Virtual Machine (KVM), on a supported mobile device. For more information, see the Integrated Dell Remote Access Controller User's Guide at <a href="#">PowerEdge Manuals</a> .

**NOTE:** For more information about the indicator codes, see the [System diagnostics and indicator codes](#) section.

## Right control panel view

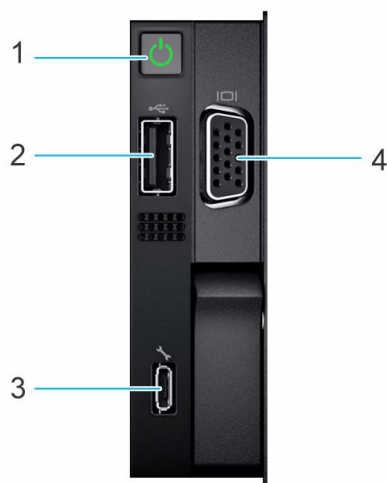






Figure 9. Right control panel

**Table 5. Right control panel**

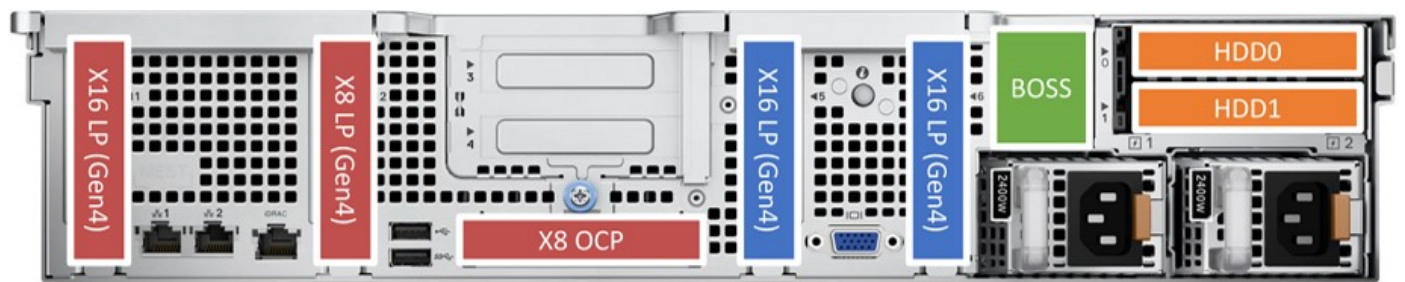
Item	Indicator or button	Icon	Description
1	Power button		Indicates if the system is powered on or off. Press the power button to manually power on or off the system. <b>NOTE:</b> Press the power button to gracefully shut down an ACPI-compliant operating system.
2	USB 2.0 port		The USB port is 4-pin, 2.0-compliant. This port enables you to connect USB devices to the system.
3	iDRAC Direct (Micro-AB USB) port		The iDRAC Direct (Micro-AB USB) port enables you to access the iDRAC direct Micro-AB USB features. For more information, see the <i>Integrated Dell Remote Access Controller User's Guide</i> at <a href="#">PowerEdge Manuals</a> . <b>NOTE:</b> You can configure iDRAC Direct by using a USB to micro USB (type AB) cable, which you can connect to your laptop or tablet. Cable length should not exceed 3 feet (0.91 meters). Performance could be affected by cable quality.
4	VGA port		Enables you to connect a display device to the system.

## Rear view of the system

**Figure 10. Rear view of the system**



**Figure 11. Rear view of the system with no riser and one CPU**



**Figure 12. Rear view of the system with no riser and two CPUs**

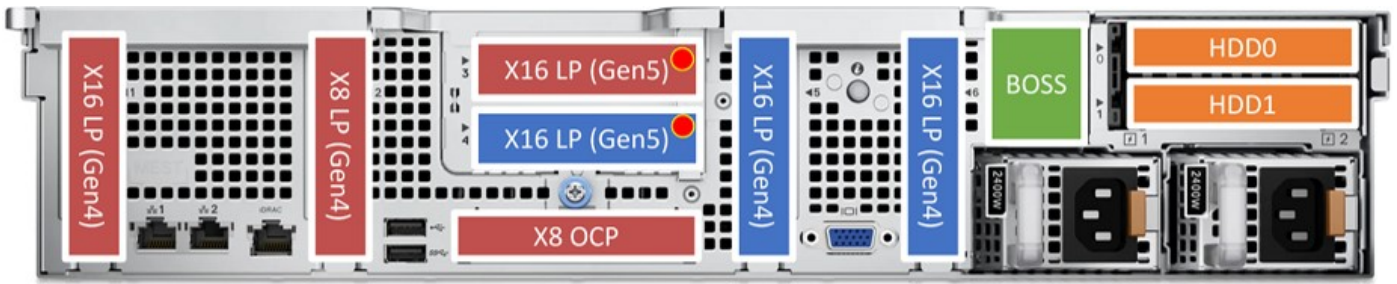


Figure 13. Rear view of the system with Riser 1c

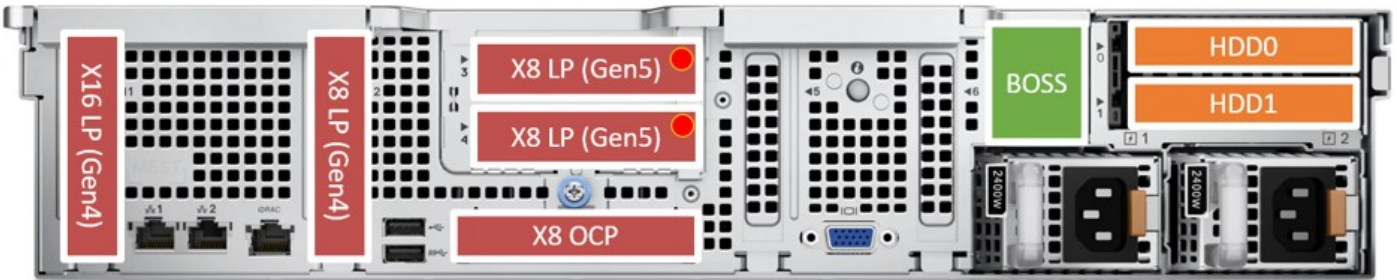
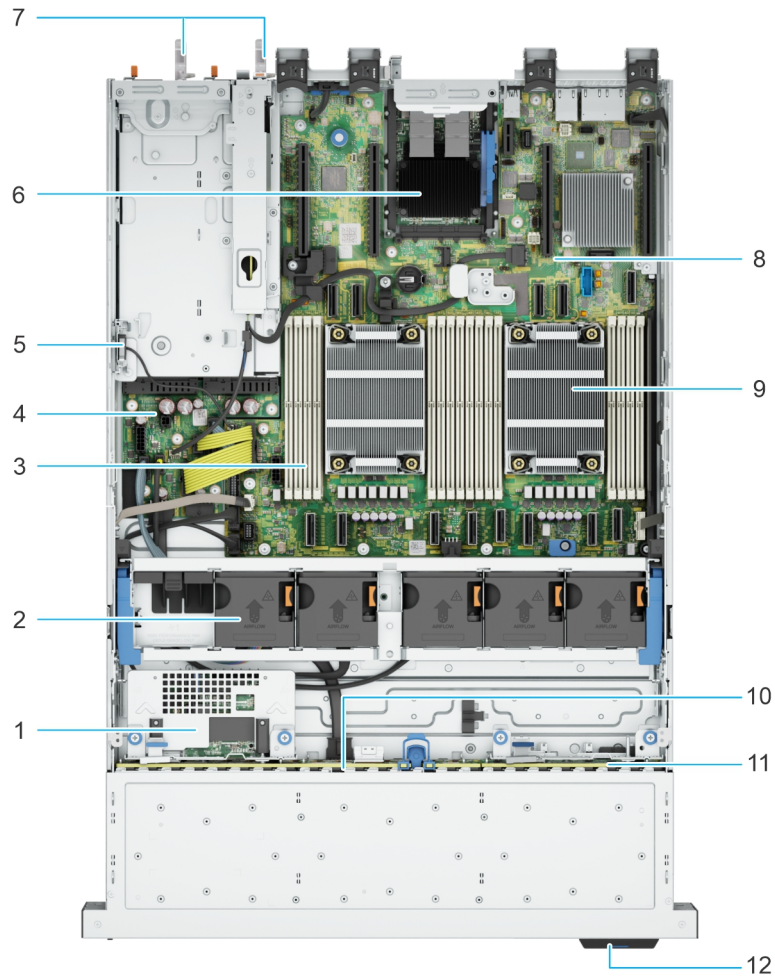


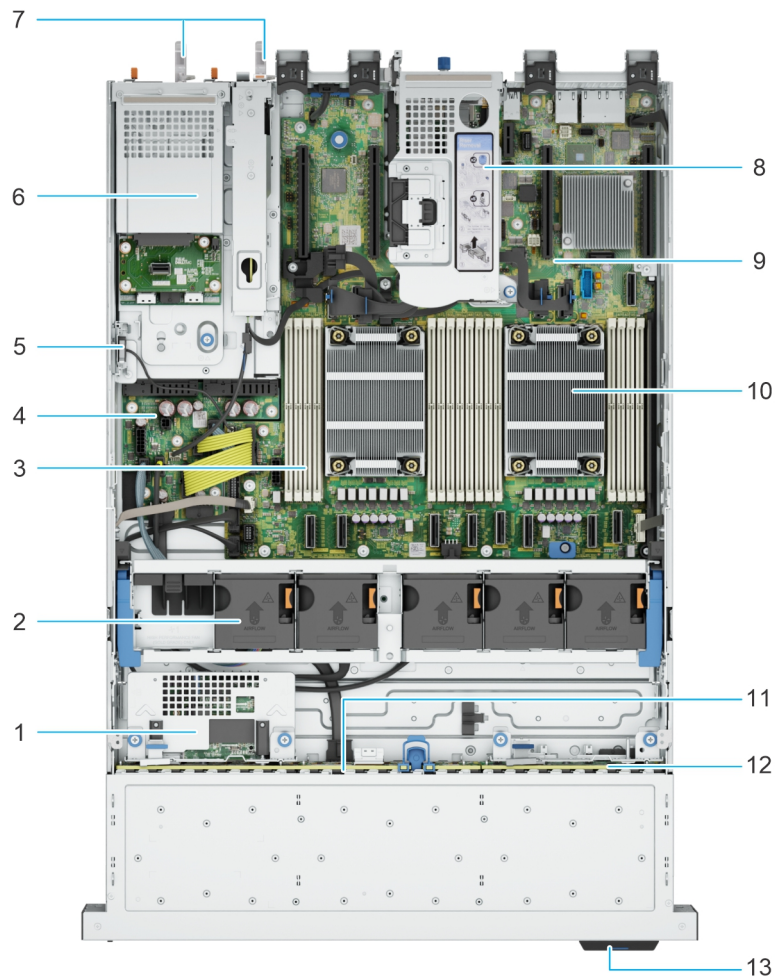
Figure 14. Rear view of the system with Riser 1d

## Inside the system



**Figure 15. Inside the system without rear drive and riser**

- |                            |                           |
|----------------------------|---------------------------|
| 1. Rear mounted front PERC | 2. Cooling fan assembly   |
| 3. Memory module slots     | 4. Power interposer board |
| 5. Intrusion switch        | 6. OCP                    |
| 7. PSU 1 and PSU 2         | 8. System board           |
| 9. Processor heat sink     | 10. SAS/SATA backplane    |
| 11. NVMe backplane         | 12. Information tag       |



**Figure 16. Inside the system with rear drive cage and riser**

- |                            |                           |
|----------------------------|---------------------------|
| 1. Rear mounted front PERC | 2. Cooling fan assembly   |
| 3. Memory module slots     | 4. Power interposer board |
| 5. Intrusion switch        | 6. Rear drive cage        |
| 7. PSU 1 and PSU 2         | 8. Riser                  |
| 9. System board            | 10. Processor heat sink   |
| 11. SAS/SATA backplane     | 12. NVMe backplane        |
| 13. Information tag        |                           |

## System diagnostics and indicator codes

The diagnostic indicators on the system front panel display system status during system startup.

### Status LED indicators

**NOTE:** The indicators display solid amber if any error occurs.

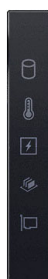







Figure 17. Status LED indicators

Table 6. Status LED indicators and descriptions

Icon	Description	Condition	Corrective action
	Drive indicator	The indicator turns solid amber if there is a drive error.	<ul style="list-style-type: none"> <li>• Check the System Event Log to determine if the drive has an error.</li> <li>• Run the appropriate Online Diagnostics test. Restart the system and run embedded diagnostics (ePSA).</li> <li>• If the drives are configured in a RAID array, restart the system, and enter the host adapter configuration utility program.</li> </ul>
	Temperature indicator	The indicator turns solid amber if the system experiences a thermal error (for example, the ambient temperature is out of range or there is a fan failure).	<p>Ensure that none of the following conditions exist:</p> <ul style="list-style-type: none"> <li>• A cooling fan has been removed or has failed.</li> <li>• System cover, air shrouds, or back filler bracket has been removed.</li> <li>• Ambient temperature is too high.</li> <li>• External airflow is obstructed.</li> </ul> <p>If the problem persists, see the <a href="#">Getting help</a> section.</p>
	Electrical indicator	The indicator turns solid amber if the system experiences an electrical error (for example, voltage out of range, or a failed power supply unit (PSU) or voltage regulator).	<p>Check the System Event Log or system messages for the specific issue. If it is due to a problem with the PSU, check the LED on the PSU. Reseat the PSU.</p> <p>If the problem persists, see the <a href="#">Getting help</a> section.</p>
	Memory indicator	The indicator turns solid amber if a memory error occurs.	<p>Check the System Event Log or system messages for the location of the failed memory. Reseat the memory module.</p> <p>If the problem persists, see the <a href="#">Getting help</a> section.</p>
	PCIe indicator	The indicator turns solid amber if a PCIe card experiences an error.	<p>Restart the system. Update any required drivers for the PCIe card. Reinstall the card.</p> <p>If the problem persists, see the <a href="#">Getting help</a> section.</p> <p><b>NOTE:</b> For more information about the supported PCIe cards, see the Expansion cards and expansion card risers &gt; Expansion card installation guidelines section.</p>

## System health and system ID indicator codes

The system health and system ID indicator is located on the left control panel of the system.



Figure 18. System health and system ID indicator

Table 7. System health and system ID indicator codes

System health and system ID indicator code	Condition
Solid blue	Indicates that the system is powered on, is healthy, and system ID mode is not active. Press the system health and system ID button to switch to system ID mode.
Blinking blue	Indicates that the system ID mode is active. Press the system health and system ID button to switch to system health mode.
Solid amber	Indicates that the system is in fail-safe mode. If the problem persists, see the <a href="#">Getting help</a> section.
Blinking amber	Indicates that the system is experiencing a fault. Check the System Event Log for specific error messages. <a href="#">EEMI guide</a>

## QR code for PowerEdge R760xs system resources



Figure 19. QR code for PowerEdge R760xs system

# Processor

## Topics:

- [Processor features](#)
- [Chipset](#)

## Processor features

The Intel 4<sup>th</sup> and 5<sup>th</sup> Generation Xeon® Scalable Processors stack is the next-generation data center processor offering with significant performance increases, integrated acceleration, and next-generation memory and I/O. Sapphire Rapids and Emerald Rapids accelerate customer usage with unique workload optimizations and provide the following feature improvements.

- Faster UPI with up to three Intel Ultra Path Interconnect (Intel UPI) at up to 20 GT/s, increasing multisocket bandwidth.
- More, faster I/O with PCI Express 5 and up to 80 lanes (per CPU)
- Enhanced Memory Performance with DDR5 support and memory speed up to 5200 MT/s in one DIMM per channel (1DPC).
- New onboard accelerators for data analytics, networking, storage, crypto, and data compression
- Enhanced security for virtualized environments with Intel Trust Domain Extensions (IntelR TDX) for confidential computing

## Supported processors

The following table shows the Intel Sapphire Rapids and Emerald Rapids SKUs that are supported on the R760xs.

**Table 8. Supported Processors for R760xs**

Processor	Clock Speed (GHz)	Cache (M)	UPI (GT/s)	Cores	Turbo	Memory Speed (MT/s)	TDP
6534	3.9	22.5	20	8	Turbo	4800	195 W
6526Y	2.8	37.5	20	16	Turbo	5200	195 W
5512U	2.1	52.5	N/A	28	Turbo	4800	185 W
4514Y	2.0	30	16	12	Turbo	4400	150 W
4510	2.4	30	16	12	Turbo	4400	150 W
4509Y	2.6	23	16	8	Turbo	4400	125 W
6448Y	2.2	60	16	32	Turbo	4800	225 W
6442Y	2.6	45	16	24	Turbo	4800	225 W
6438Y+	2	60	16	32	Turbo	4800	205 W
6426Y	2.6	30	16	16	Turbo	4800	185 W
6414U	2	60	16	32	Turbo	4800	250 W
5520+	2.2	52.5	20	28	Turbo	4800	205 W
5420+	2	53	16	28	Turbo	4400	205 W
5418Y	2	45	16	24	Turbo	4400	185 W
5416S	2	30	16	16	Turbo	4400	150 W
5415+	2.9	15	16	8	Turbo	4400	150 W
4516Y+	2.2	45	16	24	Turbo	4400	185 W

**Table 8. Supported Processors for R760xs (continued)**

Processor	Clock Speed (GHz)	Cache (M)	UPI (GT/s)	Cores	Turbo	Memory Speed (MT/s)	TDP
4416+	2	38	16	20	Turbo	4000	165 W
4410Y	2	23	16	12	Turbo	4000	150 W
4410T	2.7	27	16	10	Turbo	4000	150 W
3408U	1.8	15	16	8	Turbo	4000	125 W

## Chipset

The system supports Intel® C741 series chipset.

DMI - 3.0 speed (port width x8, x4)

USB ports - up to 10 superspeed (USB 3.1), 14 highspeed (USB 2.0)

SATA ports - up to 20 SATA port

PCIe Express - Up to 20 lanes, PCIe 3.0

## Chipset features

- PCI-E interfaces
  - Integrated PCI Express Gen5 for improved bandwidth and connectivity
  - Up to 80 lanes per processor
  - Connect PCIe x1 to iDRAC- integrated VGA chip
- Integrated USB - maximum of 10 SuperSpeed (USB 3.1), 14 highspeed (USB 2.0)
  - One front port (USB 2.0 / Right front I/O)
  - Two rear ports (USB 2.0/3.0)


# Memory subsystem

## Topics:

- Supported memory
- General memory module installation guidelines


## Supported memory


**Table 9. Memory technology comparison**

Feature	PowerEdge R760xs (DDR5)
DIMM type	RDIMM
Transfer speed	5200 MT/s (1DPC)  <b>NOTE:</b> Maximum DIMM transfer speed support depends on CPU SKU and DIMM population.
Voltage	1.1 V

**Table 10. Supported memory matrix**

DIMM type	Rank	Capacity	DIMM rated voltage and speed	Operating Speed
				1 DIMM per channel (DPC)
RDIMM	1 R	16 GB	DDR5 (1.1 V), 4800 MT/s DDR5 (1.1 V), 5600 MT/s	Up to 4800 MT/s Up to 5200 MT/s
	2 R	32 GB, 64 GB, 96 GB	DDR5 (1.1 V), 4800 MT/s DDR5 (1.1 V), 5600 MT/s	Up to 4800 MT/s Up to 5200 MT/s

 **NOTE:** 5600 MT/s RDIMMs are applicable for 5th Gen Intel® Xeon® Scalable Processors.

 **NOTE:** The processor may reduce the performance of the rated DIMM speed.

## General memory module installation guidelines

To ensure optimal performance of your system, observe the following general guidelines when configuring your system memory. If your system's memory configuration fails to observe these guidelines, your system might not boot, stop responding during memory configuration, or operate with reduced memory.

The memory bus may operate at speeds of 5200 MT/s, 4800 MT/s, 4400 MT/s or 4000 MT/s depending on the following factors:

- System profile selected (for example, Performance, Performance Per Watt Optimized (OS), or Custom [can be run at high speed or lower])
- Maximum supported DIMM speed of the processors

- Maximum supported speed of the DIMMs

**i** **NOTE:** MT/s indicates DIMM speed in MegaTransfers per second.

The system supports Flexible Memory Configuration, enabling the system to be configured and run in any valid chipset architectural configuration. The following are the recommended guidelines for installing memory modules:

- All DIMMs must be DDR5.
- Memory mixing is not supported for different DIMM capacities.
- If memory modules with different speeds are installed, they operate at the speed of the slowest installed memory module(s).
- Populate memory module sockets only if a processor is installed.
  - For single-processor systems, sockets A1 to A8 are available.
  - For dual-processor systems, sockets A1 to A8 and sockets B1 to B8 are available.
  - A minimum of 1 DIMM must be populated for each installed processor.
- In **Optimizer Mode**, the DRAM controllers operate independently in the 64-bit mode and provide optimized memory performance.

**Table 11. Memory population rules**

Processor	Configuration	Memory population	Memory population information
Single processor	Optimizer (Independent channel) population order	A{1}, A{2}, A{3}, A{4}, A{5}, A{6}, A{7}, A{8}	1, 2, 4, 6, 8 DIMMs are allowed.
Dual processor (Start with processor1. Processor 1 and processor 2 population should match)	Optimizer (Independent channel) population order	A{1}, B{1}, A{2}, B{2}, A{3}, B{3}, A{4}, B{4}, A{5}, B{5}, A{6}, B{6}, A{7}, B{7}, A{8}, B{8}	2, 4, 8, 12, 16 DIMMs are supported per system . <b>i</b> <b>NOTE:</b> Optimizer population order is not traditional for 8 and 16 DIMMs installations for dual processor.

- Always populate memory channels identically with equal DIMMs for best performance.
- Supported RDIMM configurations are 1, 2, 4, 6, and 8 DIMMs per processor.
- Supported 96 GB RDIMM configurations are 1, 6 and 8 DIMMs per processor.
- Populate eight equal memory modules per processor (one DIMM per channel) at a time to maximize performance.

**i** **NOTE:** Equal memory modules refer to DIMMs with identical electrical specification and capacity that may be from different vendors.

# Storage

## Topics:

- [Storage controllers](#)
- [Supported Drives](#)
- [External Storage](#)

## Storage controllers

Dell RAID controller options offer performance improvements, including the fPERC solution. fPERC provides a base RAID HW controller without consuming a PCIe slot by using a small form factor and high-density connector to the base planar.

16G PERC Controller offerings are a heavy leverage of 15G PERC family. The Value and Value Performance levels carry over to 16G from 15G. New to 16G is the Avenger-based Premium Performance tier offering. This high-end offering drives IOPs performance and enhanced SSD performance.

**Table 12. PERC Series controller offerings**

Performance Level	Controller and Description
Entry	S160
Value	H355, HBA355e, HBA355i, HBA465i
Value Performance	H755, H755N
Premium Performance	H965i Avenger 1 Memory: 8GB DDR4 NV cache 72-bit memory 2133 MHz Low profile form factors Dual A15 1.2 GHz CPU X8PCIe 3.0, x8 12Gb SAS

**NOTE:** For more information about the features of the Dell PowerEdge RAID controllers (PERC), Software RAID controllers, or BOSS card, and on deploying the cards, see the storage controller documentation at [Storage Controller Manuals](#).

**NOTE:** From December 2021, H355 replaces H345 as the entry raid controller. H345 is deprecated in January 2022.

## Storage controller feature matrix

**Table 13. Storage controller feature matrix**

Model & Form Factors	Interface Support	PCI Support	SAS Connection	Cache Memory Size	Write Back Cache	RAID Levels	Max Drive Support	RAID Support
PowerEdge Server-Storage Controllers (PERC) Series 12.2								

**Table 13. Storage controller feature matrix (continued)**

Model & Form Factors	Interface Support	PCI Support	SAS Connection	Cache Memory Size	Write Back Cache	RAID Levels	Max Drive Support	RAID Support
HBA465i Front	24Gb/s SAS 6Gb/s SAS/SATA	PCIe Gen 4	16 ports/lanes - 2x8 Internal	N/A	NA	N/A	16/ controller 50 with SAS Expander	N/A
PowerEdge Server-Storage Controllers (PERC) Series 12								
H965i Front	24Gb/s SAS 6Gb/s SAS/SATA Gen3 (8 GT/s) NVMe Gen4 (16 GT/s) NVMe	PCIe Gen 4	16 ports/lanes - 2x8 Internal	8GB NV	Flash Backed Cache	0,1,5,6,10,50,60	16	Hardware
H965i Adapter	24Gb/s SAS 6Gb/s SAS/SATA Gen3 (8 GT/s) NVMe Gen4 (16 GT/s) NVMe	PCIe Gen 4	16 ports/lanes - 2x8 Internal	8GB NV	Flash Backed Cache	0,1,5,6,10,50,60	16	Hardware
S160 Software RAID	Gen4 (16 GT/s) NVMe	PCIe Gen 4	N/A	No Cache	No Cache	0,1,5,10	8	Software RAID - Windows only
PowerEdge Server-Storage Controllers (PERC & SAS HBA) Series 11								
H755 Adapter	12Gb/s SAS 6Gb/s SAS/SATA 3Gb/s SAS/SATA Gen3 (8 GT/s) NVMe Gen4 (16 GT/s) NVMe	PCIe Gen 4	16 ports- 2x8 Internal	8GB NV	Flash Backed Cache	0,1,5,6,10,50,60	16/ controller 50 with SAS Expander	Hardware
H755N Front (NVMe Only)	Gen3 (8 GT/s) NVMe Gen4 (16 GT/s) NVMe	PCIe Gen 4	16 ports- 2x8 Internal	8GB NV	Flash Backed Cache	0,1,5,6,10,50,60	8/ controller	Hardware
H755 Front (SAS/SATA only)	12Gb/s SAS 6Gb/s SAS/SATA 3Gb/s SAS/SATA	PCIe Gen 4	16 ports- 2x8 Internal	8GB NV	Flash Backed Cache	0,1,5,6,10,50,60	16/ controller 50 with SAS Expander	Hardware
HBA355i Adapter	12Gb/s SAS 6Gb/s SAS/SATA 3Gb/s SAS/SATA	PCIe Gen 4	16 ports- 2x8 Internal	N/A	N/A	N/A	16/ controller 50 with SAS Expander	N/A

**Table 13. Storage controller feature matrix (continued)**

Model & Form Factors	Interface Support	PCI Support	SAS Connection	Cache Memory Size	Write Back Cache	RAID Levels	Max Drive Support	RAID Support
HBA355i Front	12Gb/s SAS 6Gb/s SAS/SATA 3Gb/s SAS/SATA	PCIe Gen 4	16 ports- 2x8 Internal	N/A	N/A	N/A	16/ controller 50 with SAS Expander	N/A
HBA355e Adapter	12Gb/s SAS 6Gb/s SAS/SATA 3Gb/s SAS/SATA	PCIe Gen 4	16 ports- 4x4 external	N/A	N/A	N/A	240	N/A
H355 Adapter	12Gb/s SAS 6Gb/s SAS/SATA	PCIe Gen 4	16 ports- 2x8 Internal	No Cache	No Cache	0,1, 10	Up to 32 RAID, or 32 Non- RAID	Hardware
H355 Front	12Gb/s SAS 6Gb/s SAS/SATA	PCIe Gen 4	16 ports- 2x8 Internal	No Cache	No Cache	0,1, 10	Up to 32 RAID, or 32 Non- RAID	Hardware

**NOTE:**

1. RAID 5/50 removed from entry RAID card
2. SWRAID support for Linux provides a pre-boot configuration utility to configure MDRAID and degraded boot capability.
3. For information, post-RTS, see the Storage controller documentation at [Storage Controller Manuals](#).

This document is updated as changes happen, so for the latest version be sure to bookmark it rather than downloading an offline copy or refer to the [Storage Controller Matrix](#) on sales portal.

## Server storage controllers User Guide

- Server-Storage Controllers User's Guides, click [here](#)

## RAID - Redundant Array of Independent Disks

- Link to Help Me Choose: RAID Configuration [here](#)

## Datasheets and PERC performance scaling decks

- Resource Page for Server-Storage (Sales Portal) click [here](#)
- PERC & SAS HBA Datasheets (To be updated)

## Boot Optimized Storage Solution (BOSS)

BOSS is a RAID solution that is designed to boot operating systems and segregate operating system boot drives from data on server-internal storage.

## BOSS feature matrix

Table 14. BOSS feature matrix

BOSS card	Drive Size	RAID levels	Stripe size	Virtual disk cache function	Maximum number of virtual disks	Maximum number of drives supported	Drive types	PCIe support	Disk cache policy	Support for Non-RAID disks	Cryptographic digital signature to verify firmware payload	Hot Plug
BOSS-N1 Monolithic	M.2 devices are read-intensive with 480 GB or 960 GB capacity	RAID1 and RAID0	Supports default 64K stripe size only	None	1	2	M.2 NVMe SSDs	Gen3	Drive default	No	Yes	Yes

### BOSS-N1

BOSS-N1 is offered as a means of booting 16G servers to a full OS when the target OS is a full OS (not just a hypervisor), or the user does not wish to trade off standard hot plug drive slots for OS install.

The HW RAID BOSS-N1 card is a RAID controller with a limited feature set that presents M.2 NVMe-only SSDs as either a RAID0 disk or a single RAID1 volume with 2 disks. BOSS-N1 enables support for 480/960 GB Disks from Factory Install.

Hardware: BOSS-N1 Controller and Carrier (x2)

Reliability: Enterprise-Class M.2 NVMe SSDs

Supports dual 80 mm, Read Intensive (1DWPD), M.2 devices 480 GB/960 GB Standard - 1.92 TB QNS

Accessibility: Front Facing

Serviceability: Full Hot-Plug Support

Supports Hardware RAID1 and RAID0

Supports UEFI boot

Marvell 88NR2241 NVMe RAID Controller

Controlled Firmware Upgrade through iDRAC

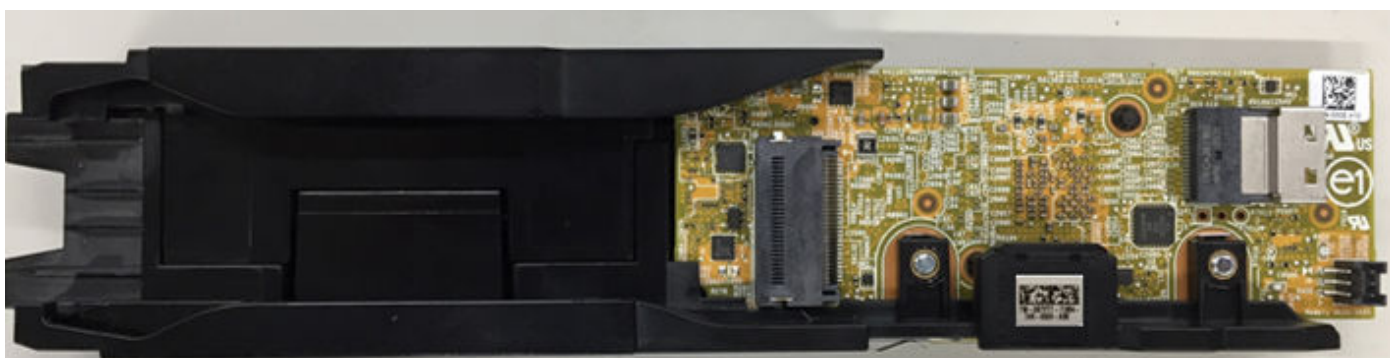


Figure 20. BOSS-N1 Controller

## Datasheets

- [BOSS-N1](#) (to be updated)

## BOSS User Guides

- [BOSS-N1](#)

## Supported Drives

The table shown below lists the internal drives supported by the R760xs. Refer to Agile for the latest SDL

**Table 15. Supported Drives**

Form Factor	Type	Speed	Rotational Speed	Capacities
2.5 inches	vSAS	12 Gb	SSD	1.92 TB, 3.84 TB, 960 GB, 7.62 TB
2.5 inches	SAS	24 Gb	SSD	1.92 TB, 1.6 TB, 800 GB, 3.84 TB, 960 GB, 7.68 TB
2.5 inches	SATA	6 Gb	SSD	1.92 TB, 480 GB, 960 GB, 3.84 TB
2.5 inches	NVMe	Gen4	SSD	1.6 TB, 3.2 TB, 6.4 TB, 1.92 TB, 3.84 TB, 15.63 TB, 7.68 TB
2.5 inches	DC NVMe	Gen4	SSD	3.84 TB, 960 GB
2.5 inches	SAS	12 Gb	10 K	600 GB, 1.2 TB, 2.4 TB
3.5 inches	SATA	6 Gb	7.2 K	2 TB, 4 TB, 8 TB, 12 TB, 16 TB, 20 TB, 24 TB
3.5 inches	SAS	12 Gb	7.2 K	2 TB, 4 TB, 8 TB, 12 TB, 16 TB, 20 TB, 24 TB

## External Storage

The R760xs support the external storage device types listed in the table below.

**Table 16. Support External Storage Devices**

Device Type	Description
External Tape	Supports connection to external USB tape products
NAS/IDM appliance software	Supports NAS software stack
JBOD	Supports connection to 12 Gb MD-series JBODs

# Networking

## Topics:

- [Overview](#)
- [OCP 3.0 support](#)

## Overview

PowerEdge offers a wide variety of options to get information moving to and from our servers. Industry best technologies are chosen, and systems management features are added by our partners to firmware to tie in with iDRAC. These adapters are rigorously validated for worry-free, fully supported use in Dell servers.

## OCP 3.0 support

**Table 17. OCP 3.0 feature list**

Feature	OCP 3.0
Form factor	SFF
PCIe Gen	Gen4
Max PCIe width	x8
Max no. of ports	4
Port type	BT/SFP/SFP+/SFP28
Max port speed	25 GbE
NC-SI	Yes
SNAPI	No
WoL	Yes
Power consumption	15 W–35 W

## Supported OCP cards

**Table 18. Supported OCP cards**

Form factor	Vendor	Port speed	Port type	Port count	DPN
OCP 3.0	Broadcom	10 GbE	BT	2	RN1M5
		25 GbE	SFP28	2	24FG6
		25 GbE	SFP28	4	3Y64D
		1 GbE	BT	4	VJWVJ
		10 GbE	BT	4	W5HC8
	Intel	1 GbE	BT	4	HY4CV

**Table 18. Supported OCP cards (continued)**

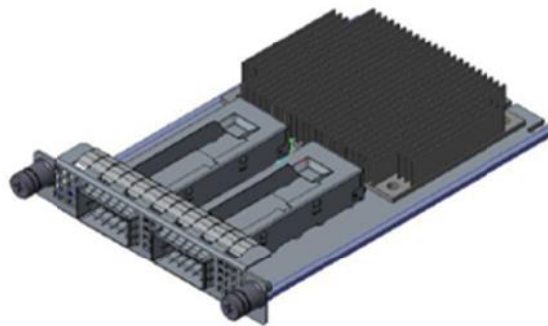
Form factor	Vendor	Port speed	Port type	Port count	DPN
		10 GbE	BT	2	F6X1R
		10 GbE	BT	4	XC0M4
		25 GbE	SFP28	2	PWH3C
		25 GbE	SFP28	4	Y4VV5

## OCP NIC 3.0 vs. rack Network Daughter Card comparisons

**Table 19. OCP 3.0, 2.0, and rNDC NIC comparison**

Form Factor	Dell rNDC	OCP 2.0 (LOM Mezz)	OCP 3.0	Notes
PCIe Gen	Gen 3	Gen 3	Gen 4	Supported OCP3 are SFF (small form factor)
Max PCIe Lanes	x8	Up to x16	Up to x8	See server slot priority matrix
Shared LOM	Yes	Yes	Yes	This is iDRAC port redirect
Aux Power	Yes	Yes	Yes	Used for Shared LOM

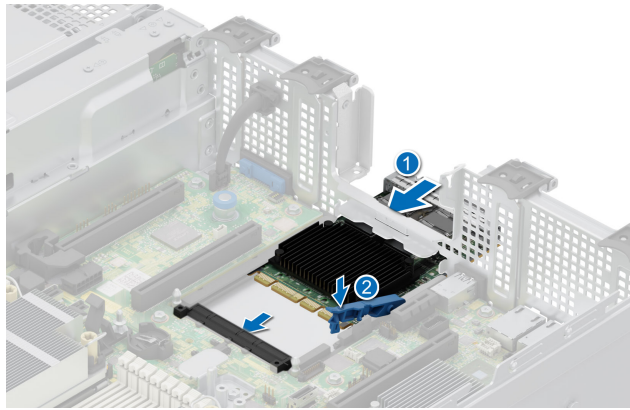
## OCP form factors



**Figure 21. OCP 3.0 Small Card Form Factor (LS)**

The process of installing the OCP card in R760xs system:

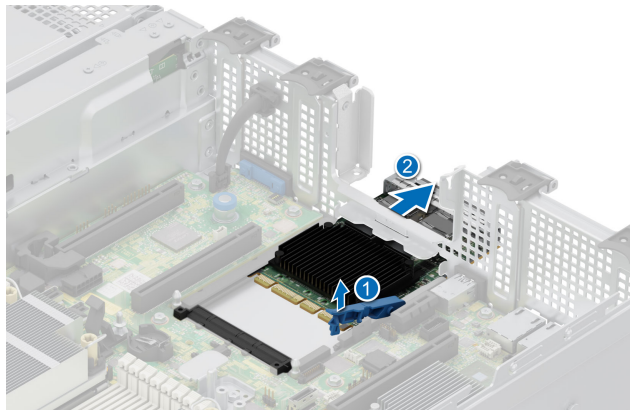
1. Open the blue latch on the system board.
2. Slide the OCP card into the slot in the system.
3. Push until the OCP card is connected to the connector on the system board.
4. Close the latch to lock the OCP card to the system.



**Figure 22. Installing the OCP Card in R760xs**

The process of removing the OCP card in R760xs system:

1. Open the blue latch to unlock the OCP card.
2. Push the OCP card towards the rear end of the system to disconnect from the connector on the system board.
3. Slide the OCP card out of the slot on the system.



**Figure 23. Removing the OCP Card in R760xs**

## Slot priority matrix

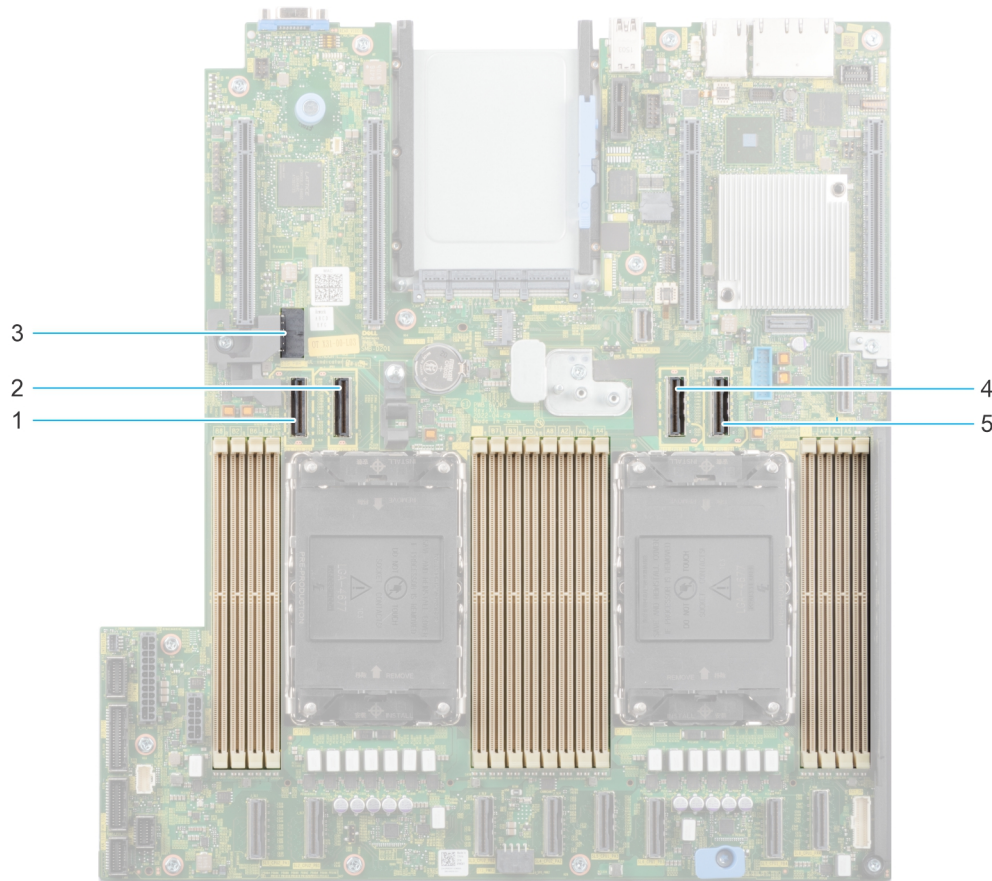
For add-in cards that can be mapped to the R760xs and guidelines for installing expansion cards, see the R760xs slot priority matrix file on Sales Portal.

Link:[Slot Priority Matrix](#)

### Topics:

- [Expansion card installation guidelines](#)

## Expansion card installation guidelines



**Figure 24. Expansion card slot connectors**

1. SL9\_CPU2\_PB5 (PCIe cable connector for Riser 1C and Riser 1D)
2. SL10\_CPU2\_PA5 (PCIe cable connector for Riser 1C and Riser 1D)
3. SIG\_PWR\_0 (Power connector for Riser 1C and Riser 1D)
4. SL11\_CPU1\_PA6 (PCIe cable connector for Riser 1D)
5. SL12\_CPU1\_PB6 (PCIe cable connector for Riser 1D)

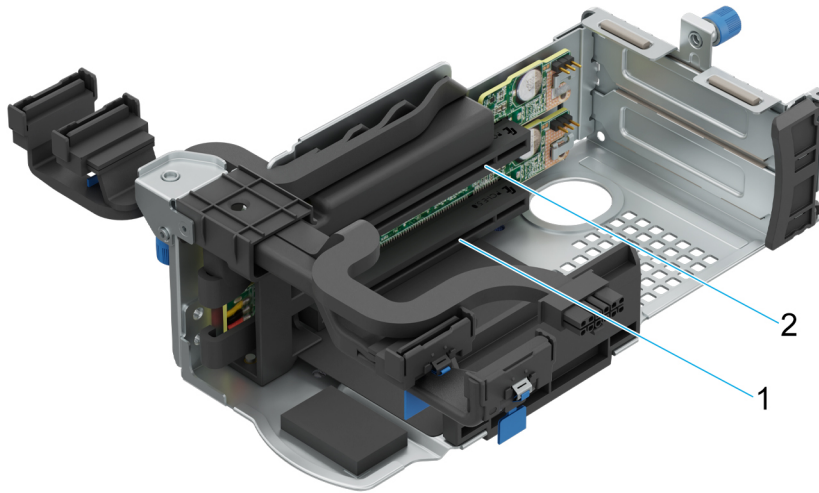
The following table describes the expansion card riser configurations:

**Table 20. Expansion card riser configurations**

Configurations	Expansion card risers	PCIe Slots	Controlling processor	Height	Length	Slot width	Power
Config 0-1.	No riser	1, 2	Processor 1	Low profile	Half length	x16, x8	75 W
Config 0-2.	No riser	1, 2	Processor 1	Low profile	Half length	x16, x8	75 W
		5, 6	Processor 2	Low profile	Half length	x16, x16	75 W
Config 1.	R1C	1, 2, 3	Processor 1	Low profile	Half length	x16, x8, x16	75 W
		4, 5, 6	Processor 2	Low profile	Half length	x16, x16, x16	75 W
Config 2.	R1D	1, 2, 3, 4	Processor 1	Low profile	Half length	x16, x8, x8, x8	75 W

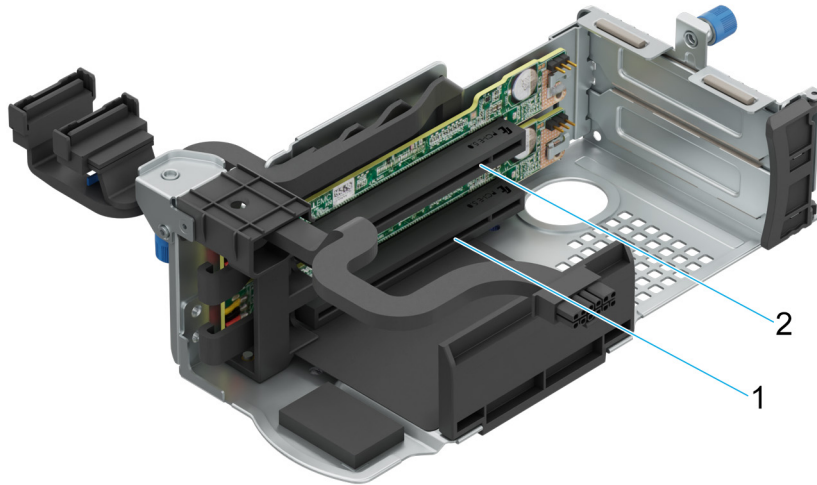
**NOTE:** Only one cable riser can be installed at a time in any given configuration.

**NOTE:** The slots 1, 2, 5 and 6 are Gen4 slots, slots 3 and 4 located on risers are Gen5 slots.



**Figure 25. Riser 1C**

- 1. Slot 3
- 2. Slot 4



**Figure 26. Riser 1D**

- 1. Slot 3
- 2. Slot 4

**NOTE:** The expansion-card slots are not hot-swappable.

The following table provides guidelines for installing expansion cards to ensure proper cooling and mechanical fit. The expansion cards with the highest priority should be installed first using the slot priority indicated. All the other expansion cards should be installed in the card priority and slot priority order.

**Table 21. Configuration 0-1: No riser configuration 1 CPU**

Card type	Slot priority	Maximum number of cards
Dell Serial port module (LP)	2	1
fPERC	Integrated slot	1
Internal PERC adapter	1	1
Dell External Adapter (HBA)	2, 1	2
Dell External Adapter	1	1
Mellanox (NIC: NDR400)	Not supported	N/A
Mellanox (NIC: NDR200)	Not supported	N/A
Mellanox (NIC: 100Gb)	1	1
Mellanox HDR100 VPI	1	1
Mellanox HDR VPI	1	1
Mellanox (NIC: 25Gb)	2, 1	2
Broadcom (NIC: 100Gb)	1	1
Intel (NIC: 100Gb)	1	1
Broadcom (SFP: 25Gb)	2, 1	2
Intel (NIC: 25Gb)	2, 1	2
Qlogic (NIC: 25Gb)	Not supported	N/A
Qlogic (NIC: 10Gb)	Not supported	N/A
SolarFlare (NIC: 25Gb)	Not supported	N/A
Broadcom (NIC: 25Gb)	2,1	2

**Table 21. Configuration 0-1: No riser configuration 1 CPU (continued)**

Card type	Slot priority	Maximum number of cards
Broadcom (HBA: FC64)	2,1	2
Broadcom (HBA: FC32)	2, 1	2
Marvell (HBA: FC32)	2, 1	2
Emulex (HBA: FC32)	Not supported	N/A
Avago (HBA: FC16)	Not supported	N/A
Qlogic (HBA: FC16)	Not supported	N/A
Broadcom (NIC: 10Gb)	2, 1	2
Intel (NIC: 10Gb)	2, 1	2
Qlogic (NIC: 10Gb)	Not supported	N/A
Broadcom (NIC: 1Gb)	2, 1	N/A
Intel (NIC: 1Gb)	2, 1	2
Intel (OCP: 100Gb)	Not supported	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Marvell (OCP: 25Gb)	Not supported	N/A
SolarFlare (OCP: 25Gb)	Not supported	N/A
Broadcom (OCP: 10Gb)	Integrated slot	1
Marvell (OCP: 10Gb)	Not supported	N/A
Intel (OCP: 10Gb)	Integrated slot	N/A
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	N/A
Dell BOSS N1 Module	Integrated slot	1

**Table 22. Configuration 0-2: No riser configuration 2 CPUs**

Card type	Slot priority	Maximum number of cards
Dell Serial port module (LP)	2	1
fPERC	Integrated slot	1
Internal PERC adapter	1	1
Dell External Adapter HBA	6, 2, 1, 5	4
Dell External Adapter	6, 1, 5	3
Mellanox (NIC: NDR400)	Not supported	N/A
Mellanox (NIC: NDR200)	6, 5	N/A
Mellanox (NIC: NDR200 VPI)	6, 5	2
Mellanox (NIC: 100Gb)	6, 1, 5	3
Mellanox (NIC: 25Gb)	6, 2, 1, 5	3
Mellanox HDR100 VPI	6, 1, 5	3
Mellanox HDR VPI	6, 1, 5	3
Broadcom (NIC: 100Gb)	6, 1, 5	3

**Table 22. Configuration 0-2: No riser configuration 2 CPUs (continued)**

Card type	Slot priority	Maximum number of cards
Intel (NIC: 100Gb)	6, 1, 5	3
Broadcom (NIC: 25Gb)	6, 2, 1, 5	4
Intel (NIC: 25Gb)	6, 2, 1, 5	2
Qlogic (NIC: 25Gb)	Not supported	N/A
Qlogic (NIC: 10Gb)	Not supported	N/A
SolarFlare (NIC: 25Gb)	Not supported	N/A
Broadcom (HBA: FC64)	6, 2, 1, 5	4
Broadcom (HBA: FC32)	6, 2, 1, 5	4
Qlogic (HBA: FC32)	6, 2, 1, 5	4
Marvell (HBA: FC32)	6, 2, 1, 5	4
Emulex (HBA: FC32)	Not supported	N/A
Avago (HBA: FC16)	Not supported	N/A
Qlogic (HBA: FC16)	Not supported	N/A
Broadcom (NIC: 10Gb)	6, 2, 1, 5	4
Intel (NIC: 10Gb)	6, 2, 1, 5	4
Qlogic (NIC: 10Gb)	Not supported	N/A
Broadcom (NIC: 1Gb)	6, 2, 1, 5	4
Intel (NIC: 1Gb)	6, 2, 1, 5	4
Intel (OCP: 100Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Marvell (OCP: 25Gb)	Not supported	N/A
SolarFlare (OCP: 25Gb)	Not supported	N/A
Broadcom (OCP: 10Gb)	Integrated slot	1
Marvell (OCP: 10Gb)	Not supported	N/A
Intel (OCP: 10Gb)	Integrated slot	N/A
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	N/A
Dell BOSS N1 Module	Integrated slot	1

**Table 23. Configuration 1: R1C (CPU 1+ CPU 2)**

Card type	Slot priority	Maximum number of cards
Dell Serial port module (LP)	2	1
Internal PERC adapter	1	1
Dell external PERC adapter	6, 1, 3, 5, 4	5
12Gbps SAS HBA	1	1
Mellanox (NIC: NDR400)	4, 3	2
Mellanox (NIC: NDR400 VPI)	4, 3	2

**Table 23. Configuration 1: R1C (CPU 1+ CPU 2) (continued)**


<b>Card type</b>	<b>Slot priority</b>	<b>Maximum number of cards</b>
Mellanox (NIC: NDR200)	4, 3, 6, 5	4
Mellanox (NIC: NDR200 VPI)	4, 3, 6, 5	4
Broadcom (NIC: 100Gb)	6, 1, 3, 5, 4	5
Intel (NIC: 100Gb)	6, 1, 3, 5, 4	5
Mellanox (NIC: 100Gb)	6, 1, 3, 5, 4	5
Mellanox HDR100 VPI	6, 1, 3, 5, 4	5
Mellanox HDR VPI	6, 1, 3, 5, 4	5
Intel (NIC: 25Gb)	6, 2, 1, 3, 5, 4	6
Mellanox (NIC: 25Gb)	6, 1, 3, 5, 4	5
Qlogic (NIC: 25Gb)	Not Supported	N/A
Broadcom (NIC: 10Gb)	6, 2, 1, 3, 5, 4	6
Broadcom (NIC: 25Gb)	6, 2, 1, 3, 5, 4	6
SolarFlare (NIC: 25Gb)	Not Supported	N/A
Broadcom (HBA: FC64)	6, 2, 1, 3, 5, 4	6
Broadcom (HBA: FC32)	6, 2, 1, 3, 5, 4	6
QLogic (HBA: FC32)	6, 2, 1, 3, 5, 4	6
Marvell (HBA: FC32)	6, 2, 1, 3, 5, 4	6
Emulex (HBA: FC32)	Not Supported	N/A
Avago (HBA: FC16)	Not Supported	N/A
QLogic (HBA: FC16)	Not Supported	N/A
Intel (NIC: 10Gb)	6, 2, 1, 3, 5, 4	6
Qlogic (NIC: 10Gb)	Not Supported	N/A
Intel (NIC: 1Gb)	6, 2, 1, 3, 5, 4	6
Broadcom (NIC: 1Gb)	6, 2, 1, 3, 5, 4	6
Mellanox (NIC: 100Gb)	6, 1, 3, 5, 4	5
Intel (OCP: 100Gb)	Integrated slot	1
Mellanox (NIC: 25Gb)	6, 1, 3, 5, 4	5
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Marvell (OCP: 25Gb)	Not supported	N/A
SolarFlare (OCP: 25Gb)	Not supported	N/A
Broadcom (OCP: 10Gb)	Integrated slot	1
Marvell (OCP: 10Gb)	Not supported	N/A
Intel (OCP: 10Gb)	Integrated slot	N/A
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	N/A
Dell BOSS N1 Module	Integrated slot	1

**Table 24. Configuration 2: R1D (CPU 1)**

<b>Card type</b>	<b>Slot priority</b>	<b>Maximum number of cards</b>
Dell Serial port module (LP)	2	1
Internal PERC adapter	1	1
Dell external PERC (HBA)	4, 3, 2, 1	4
Dell external PERC adapter	1	4
12Gbps SAS HBA	1	1
Mellanox (NIC: 400Gb)	Not supported	N/A
Mellanox (NIC: 200Gb)	Not supported	N/A
Broadcom (NIC: 100Gb)	1	1
Intel (NIC: 100Gb)	1	1
Mellanox (NIC: 100Gb)	1	1
Mellanox HDR100 VPI	1	1
Mellanox HDR VPI	1	1
Intel (NIC: 25Gb)	4, 3, 2, 1	4
Mellanox (NIC: 25Gb)	4, 3, 2, 1	4
Qlogic (NIC: 25Gb)	Not Supported	N/A
Broadcom (NIC: 10Gb)	4, 3, 2, 1	4
Broadcom (NIC: 25Gb)	4, 3, 2, 1	4
SolarFlare (NIC: 25Gb)	Not Supported	N/A
Broadcom (HBA: FC64)	4, 3, 2, 1	4
Broadcom (HBA: FC32)	4, 3, 2, 1	4
QLogic (HBA: FC32)	4, 3, 2, 1	4
Marvell (HBA: FC32)	4, 3, 2, 1	4
Emulex (HBA: FC32)	Not Supported	N/A
Avago (HBA: FC16)	Not Supported	N/A
QLogic (HBA: FC16)	Not Supported	N/A
Intel (NIC: 10Gb)	4, 3, 2, 1	4
Qlogic (NIC: 10Gb)	Not Supported	N/A
Broadcom (NIC: 1Gb)	4, 3, 2, 1	4
Intel (NIC: 1Gb)	4, 3, 2, 1	4
Intel (OCP: 100Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Marvell (OCP: 25Gb)	Not supported	N/A
SolarFlare (OCP: 25Gb)	Not supported	N/A
Broadcom (OCP: 10Gb)	Integrated slot	1
Marvell (OCP: 10Gb)	Not supported	N/A
Intel (OCP: 10Gb)	Integrated slot	N/A

**Table 24. Configuration 2: R1D (CPU 1) (continued)**

<b>Card type</b>	<b>Slot priority</b>	<b>Maximum number of cards</b>
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	N/A
Dell BOSS N1 Module	Integrated slot	1

 **NOTE:** The serial COM card is not a real PCIe add-in card and has a dedicated slot on the system board.

# Power, thermal, and acoustics

PowerEdge servers have an extensive collection of sensors that automatically track thermal activity, which helps to regulate temperature by reducing server noise and power consumption. The table below lists the tools and technologies Dell offers to lower power consumption and increase energy efficiency.

## Topics:

- [Power](#)
- [Thermal](#)
- [Acoustics](#)

## Power

**Table 25. Power tools and technologies**

Feature	Description
Power Supply Units(PSU) portfolio	Dell's PSU portfolio includes intelligent features such as dynamically optimizing efficiency while maintaining availability and redundancy. Find additional information in the Power supply units section.
Tools for right sizing	Enterprise Infrastructure Planning Tool (EIPT) is a tool that can help you determine the most efficient configuration possible. With Dell's EIPT, you can calculate the power consumption of your hardware, power infrastructure, and storage at a given workload. Learn more at <a href="#">Dell Calc</a> .
Industry Compliance	Dell's servers are compliant with all relevant industry certifications and guide lines, including 80 PLUS, Climate Savers and ENERGY STAR.
Power monitoring accuracy	PSU power monitoring improvements include: <ul style="list-style-type: none"> <li>• Dell's power monitoring accuracy is currently 1%, whereas the industry standard is 5%</li> <li>• More accurate reporting of power</li> <li>• Better performance under a power cap</li> </ul>
Power capping	Use Dell's systems management to set the power cap limit for your systems to limit the output of a PSU and reduce system power consumption. Dell is the first hardware vendor to leverage Intel Node Manager for circuit-breaker fast capping.
Systems Management	iDRAC Enterprise and Datacenter provides server-level management that monitors, reports and controls power consumption at the processor, memory and system level.  Dell OpenManage Power Center delivers group power management at the rack, row, and data center level for servers, power distribution units, and uninterruptible power supplies.
Active power management	Intel Node Manager is an embedded technology that provides individual server-level power reporting and power limiting functionality. Dell offers a complete power management solution comprised of Intel Node Manager accessed through Dell iDRAC9 Datacenter and OpenManage Power Center that allows policy-based management of power and thermal at the individual server, rack, and data center level. Hot spare reduces power consumption of redundant power supplies. Thermal control off a speed optimizes the thermal settings for your environment to reduce fan consumption and lower system power consumption.  Idle power enables Dell servers to run as efficiently when idle as when at full workload.
Rack infrastructure	Dell offers some of the industry's highest-efficiency power infrastructure solutions, including:

**Table 25. Power tools and technologies (continued)**

Feature	Description
	<ul style="list-style-type: none"> <li>Power distribution units (PDUs)</li> <li>Uninterruptible power supplies (UPSs)</li> <li>Energy Smart containment rack enclosures</li> </ul> Find additional information at: <a href="#">Power-and-Cooling</a> .

## PSU specifications

The PowerEdge R760xs system supports up to two AC or DC power supply units (PSUs).

**Table 26. R760xs PSU specifications**

PSU	Class	Heat dissipation (maximum) (BTU/hr)	Frequency (Hz)	AC Voltage		DC Voltage	-48 V DC	277 V AC and HVDC	
				Low Line AC (100–120 V)	High Line AC (200–240 V)			240 V DC	-40 V to -72 V DC
600 W mixed mode	Platinum	2250	50/60	600 W	600 W	600 W	N/A	N/A	N/A
700 W mixed mode HLAC	Titanium	2625	50/60	N/A	700 W	700 W	N/A	N/A	N/A
800 W mixed mode	Platinum	3000	50/60	800 W	800 W	800 W	N/A	N/A	N/A
1100 W -48 V DC	N/A	4265	N/A	N/A	N/A	N/A	1100 W	N/A	N/A
1100 W mixed mode	Titanium	4125	50/60	1050 W	1100 W	1100 W	N/A	N/A	N/A
1400 W mixed mode	Titanium	5250	50/60	1050 W	1400 W	1400 W	N/A	N/A	N/A
1400 W mixed mode	Platinum	5250	50/60	1050 W	1400 W	1400 W	N/A	N/A	N/A
1400 W 277 V AC and HVDC	Titanium	5250	50/60	N/A	N/A	N/A	N/A	1400 W	1400 W
1800 W mixed mode HLAC	Titanium	6610	50/60	N/A	1800 W	1800 W	N/A	N/A	N/A

- NOTE:** Heat dissipation is calculated using the PSU wattage rating.
- NOTE:** HLAC stands for High-Line AC, with a range of 200 - 240V AC. HVDC stands for High-Voltage DC, with 336 V DC.
- NOTE:** When selecting or upgrading the system configuration, to ensure optimum power utilization, verify the system power consumption with the Enterprise Infrastructure Planning Tool available at [calc](#).
- NOTE:** If a system with AC 1400 W or 1100 W PSUs operates at low line 100-120 Vac, and then the power rating per PSU is degraded to 1050 W.

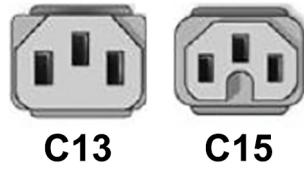


Figure 27. PSU power cords

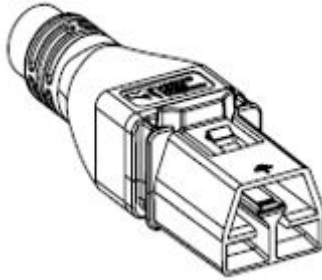


Figure 28. APP 2006G1 power cord

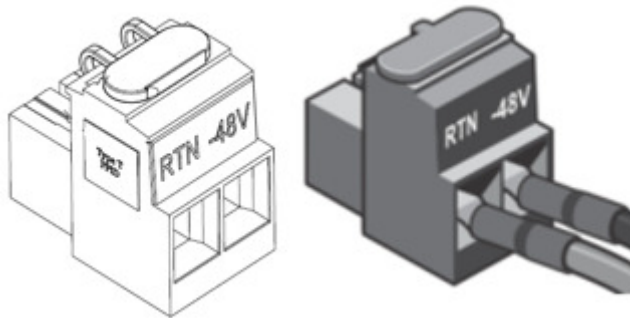


Figure 29. Lotes DC PSU connector

Table 27. PSU power cords

Form factor	Output	Power cord
Redundant 60 mm	600 W Mixed Mode	C13
	700 W Mixed Mode HLAC	C13
	800 W Mixed Mode	C13
	1100 W Mixed Mode	C13
	1100 W -48 V DC	Lotes DC PSU connector
	1400 W Mixed Mode	C13
	1400 W 277 VAC and 336 VDC	APP 2006G1
	1800 W Mixed Mode HLAC	C15

**NOTE:** C13 power cord combined with C14 to C15 jumper power cord can be used to adapt 1800 W PSU.

# Thermal

PowerEdge servers have an extensive collection of sensors that automatically track thermal activity, which helps regulate temperature thereby reducing server noise and power consumption.

# Acoustics

## Acoustical configurations of R760xs

Dell PowerEdge R760xs is a rack server appropriate for attended data center environment. However, lower acoustical output is attainable with proper hardware or software configurations.

**Table 28. Configurations tested for acoustical experience**

Configuration	Quietest	12 x 3.5-inch configuration	Quietest - GPU	Volume 1 - 2.5-inch	Volume 2 - 3.5-inch with Rear Storage
CPU TDP	125 W	185 W	150 W	185 W	185 W
CPU Quantity	1	2	2	2	2
RDIMM Memory	16 GB DDR5	32 GB DDR5	16 GB DDR5	16 GB DDR5	32 GB DDR5
Memory Quantity	2	16	4	16	16
Backplane Type	8 x 2.5-inch BP	12 x 3.5-inch BP	8 x 2.5-inch BP	8 x 2.5-inch + 8 x 2.5-inch NVMe BP	12 x 3.5-inch + rear 2 x 2.5-inch BP
HDD Type	SATA 2.5-inch 480 GB	SATA 3.5-inch 12 TB	SATA 2.5-inch 480 GB	SAS 2.5-inch + NVMe 2.5-inch	SATA 3.5-inch 12 TB + rear 2.5-inch U.2 NVMe
HDD Quantity	1	12	4	8+8	12+2
Flash Drives	X	X	X	X	X
Flash Quantity	X	X	X	X	X
PSU Type	600 W	1400 W	800 W	800 W	1400 W
PSU Quantity	1	2	2	2	2
OCP	1G	10/25 2-port	1G	10/25 2-port	10/25 2-port
PCI 1	X	X	X	X	X
PCI 2	X	2-port 25Gb	X	2-port 25Gb	2-port 25Gb
PCI 3	X	X	X	X	X
PCI 4	X	X	A2	X	X
PCI 5	X	2-port 25 Gb	X	2-port 25 Gb	2-port 25 Gb
PCI 6	X	X	X	X	X
PERC	Front H355i	Front H755	Front H355i	Front H755	Rear H755

**Table 29. Acoustical experience of R760 configurations**

Configuration	Quietest	12 x 3.5-inch configuration	Quietest - GPU	Volume 1 - 2.5-inch	Volume 2 - 3.5-inch with Rear Storage
Acoustical Performance: Idle/ Operating @ 25°C Ambient					
L <sub>wA,m</sub> (B)	Idle <sup>(4)</sup>	4.6	7.0	6.4	6.4
					7.2

**Table 29. Acoustical experience of R760 configurations (continued)**

Configuration		Quietest	12 x 3.5-inch configuration	Quietest - GPU	Volume 1 - 2.5-inch	Volume 2 - 3.5-inch with Rear Storage
	Operating/Customer usage operating <sup>(5)(6)</sup>	4.6	7.0	8.0	6.4	7.2
K <sub>v</sub> (B)	Idle <sup>(4)</sup>	0.4	0.4	0.4	0.4	0.4
	Operating/Customer usage operating <sup>(5)(6)</sup>	0.4	0.4	0.4	0.4	0.4
L <sub>pA,m</sub> (dB)	Idle <sup>(4)</sup>	32	56	50	49	57
	Operating/Customer usage operating <sup>(5)(6)</sup>	32	56	64	50	58
Prominent discrete tones <sup>(3)</sup>		Prominence ratio < ECMA-74	Prominence ratio < 15 dB			
Acoustical Performance: Idle @ 28°C Ambient						
L <sub>wA,m</sub> <sup>(1)</sup> (B)		4.8	7.2	6.6	6.6	7.4
K <sub>v</sub> (B)		0.4	0.4	0.4	0.4	0.4
L <sub>pA,m</sub> <sup>(2)</sup> (dB)		33	56	52	52	58
Acoustical Performance: Max. loading @ 35°C Ambient						
L <sub>wA,m</sub> <sup>(1)</sup> (B)		5.4	8.0	8.6	8.1	8.1
K <sub>v</sub> (B)		0.4	0.4	0.4	0.4	0.4
L <sub>pA,m</sub> <sup>(2)</sup> (dB)		38	66	70	65	65

<sup>(1)</sup>L<sub>wA,m</sub>: The declared mean A-weighted sound power level (L<sub>wA</sub>) is calculated per section 5.2 of ISO 9296 with data collected using the methods described in ISO 7779 (2010). Engineering data presented here may not be fully compliant with ISO 7779 declaration requirements.

<sup>(2)</sup>L<sub>pA,m</sub>: The declared mean A-weighted emission sound pressure level is at the bystander position per section 5.3 of ISO 9296 and measured using methods described in ISO 7779. The system is placed in a 24U rack enclosure, 25cm above a reflective floor. Engineering data presented here may not be fully compliant with ISO 7779 declaration requirements.

<sup>(3)</sup>Prominent tones: Criteria of Annex D of ECMA-74 & Prominence Ratio method of ECMA-418 are followed to determine if discrete tones are prominent and to report them, if so.

<sup>(4)</sup>Idle mode: Idle mode is the steady-state condition in which the server is energized but not operating any intended function.

<sup>(5)</sup>Operating mode: Operating mode is represented by the maximum of the steady state acoustical output at 50% of CPU TDP or active storage drives for the respective sections of Annex C of ECMA-74.

<sup>(6)</sup> Customer Usage Operating mode: The operating mode is represented by the maximum of the steady state acoustical output at 10%~25% of CPU TDP, 0%~10% IOPs load, and >80% GPU load as the components showed in the above configurations.

# Rack, rails, and cable management

## Topics:

- [Rails information](#)
- [Cable Management Arm](#)
- [Strain Relief Bar](#)
- [Rack Installation](#)

## Rails information

The rail offerings for the R760xs consist of two general types: sliding and static. The cable management offerings consist of an optional cable management arm (CMA) and an strain relief bar (SRB).

See the *Dell Enterprise Systems Rail Sizing and Rack Compatibility Matrix* available at [rail-rack-matrix](#) for information regarding:

- Specific details about rail types.
- Rail adjustability ranges for various rack mounting flange types
- Rail depth with and without cable management accessories
- Rack types that are supported for various rack mounting flange types

Key factors governing proper rail selection include the following:

- Identifying the type of rack in which they will be installed.
- The spacing between the front and rear mounting flanges of the rack.
- The type and location of any equipment mounted in the back of the rack such as power distribution units (PDUs), and the overall depth of the rack
- Overall depth of the rack

## A11 Sliding Rails features summary

The sliding rails allow the system to be fully extended out of the rack for service. The sliding rails have a Cable Management Arm (CMA) and a Strain Relief Bar (SRB) option.

There are one types of sliding rails available:

- Stab-in/Drop-in sliding rails

### A11 Stab-in/Drop-in sliding rails for 4-post racks

- Supports Drop-in or Stab-in installation of the chassis to the rails
- Supports tool-less installation in 19-inch EIA-310-E compliant square, unthreaded round hole racks including all generations of Dell racks.

Also supports tool-less installation in threaded round hole 4-post racks

- Support for tool-less installation in Dell Titan or Titan-D racks
- Supports full extension of the system out of the rack to allow serviceability of key internal components
- **NOTE:** For situations where CMA support is not required, the outer CMA mounting brackets can be uninstalled from the sliding rails. This reduces the overall length of the rails and eliminates the potential interferences with rear mounted PDUs or the rear rack door.

Supports optional Cable Management Arm (CMA)

- Supports optional Strain Relief Bar (SRB)

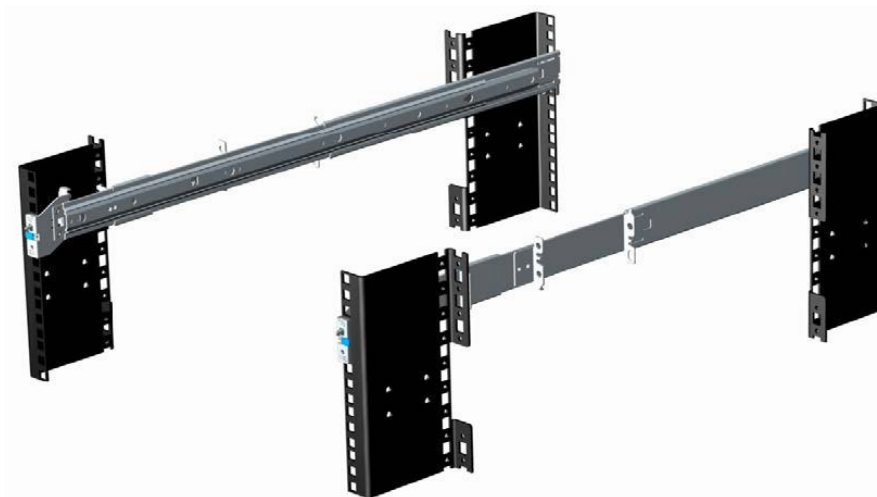
## A8 Static Rails features summary

The static rails, which are shown in the figure below, support a wider variety of racks than the sliding rails, but do not support serviceability in the rack. The static rails are not compatible with the CMA and SRB.

- Supports Stab-in installation of the chassis to the rails
- Supports tool-less installation in 19-inch EIA-310-E compliant square or unthreaded round hole 4-post racks including all generations of Dell racks
- Supports tooled installation in 19-inch EIA-310-E compliant threaded hole 4-post and 2-post racks
- Supports tooled installation in Dell Titan or Titan-D rack

### **i** NOTE:

- Screws are not included with the static rail kit since racks are offered with various thread types.
- Screw head diameter should be 10mm or less.



**Figure 30. Static rails**

### **2-Post racks installation**

If installing to 2-Post (Telco) racks, the ReadyRails II static rails (A8) must be used. Sliding rails support mounting in 4-post racks only.



**Figure 31. Static rails in 2-post center mount configuration**

### Installation in the Dell Titan or Titan-D racks

For tool-less installation in Titan or Titan-D racks, the Stab-in/Drop-in sliding rails (A11) must be used. This rail collapses down sufficiently to fit in the rack with mounting flanges that are spaced about 24 inches apart from front to back. The Stab-in/Drop-in sliding rail allows bezels of the servers and storage systems to be aligned when installed in these racks. For tooled installation, Stab-in Static rails (A8) must be used for bezel alignment with storage systems.

## Cable Management Arm

The optional Cable Management Arm (CMA) for the system organizes and secures the cords and cables exiting the back of the server and unfolds to allow the server to extend out of the rack without having to detach the cables.

Some key features of the CMA include:

- Large U-shaped baskets to support dense cable loads
- Open vent pattern for optimal airflow
- Support for mounting on either side by swinging the spring-loaded brackets from one side to the other
- Utilizes hook-and-loop straps rather than plastic tie wraps to eliminate the risk of cable damage during cycling
- Includes a low-profile fixed tray to both support and retain the CMA in its fully closed position
- Both the CMA and the tray mount without the use of tools through simple and intuitive snap-in designs

The CMA can be mounted to either side of the sliding rails without the use of tools or the need for conversion. For systems with one power supply unit (PSU), it is recommended to mount on the side opposite to that of the power supply to allow easier access to it and the rear drives (if applicable) for service or replacement.

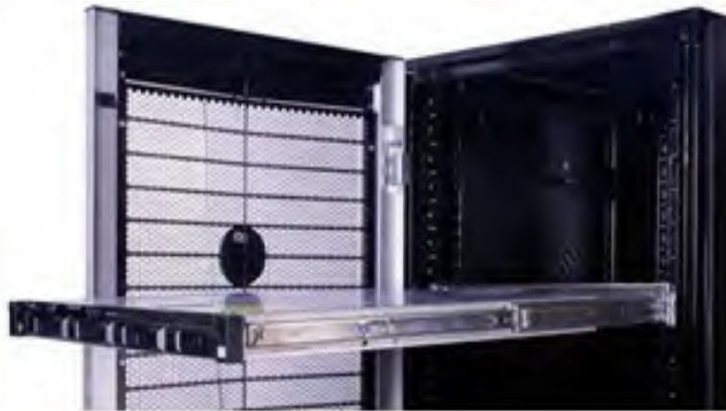
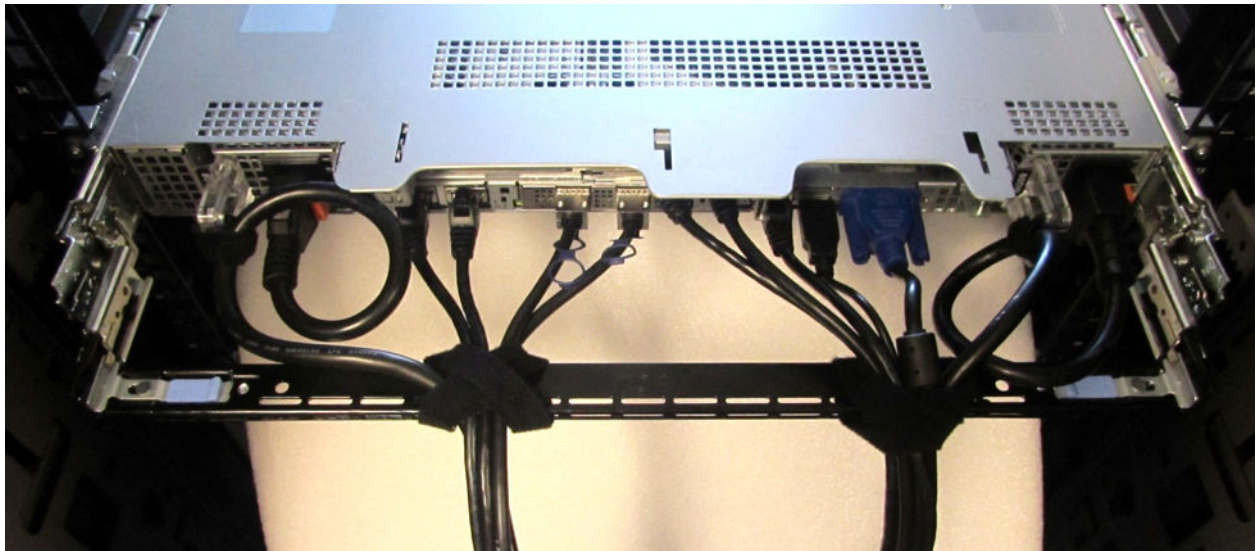


Figure 32. Cable Management Arm

## Strain Relief Bar

The optional strain relief bar (SRB) for the R760xs organizes and supports cable connections at the rear end of the server to avoid damage from bending.



**Figure 33. Cabled strain relief bar**

Sliding rails with optional SRB:

- Support tool-less attachment to rails
- Support two depth positions to accommodate various cable loads and rack depths
- Support cable loads and controls stress on server connectors
- Support cables can be segregated into discrete, purpose-specific bundles

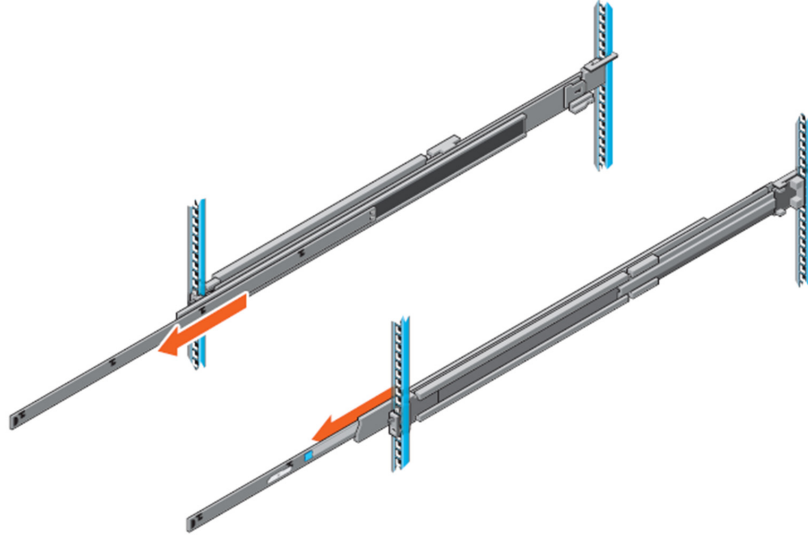
## Rack Installation

Drop-in design means that the system is installed vertically into the rails by inserting the standoffs on the sides of the system into the J-slots in the inner rail members with the rails in the fully extended position. The recommended method of installation is to first insert the rear standoffs on the system into the rear J-slots on the rails to free up a hand and then rotate the system down into the remaining J-slots while using the free hand to hold the rail against the side of the system.

Stab-in design means that the inner (chassis) rail members must first be attached to the sides of the system and then inserted into the outer (cabinet) members installed in the rack.

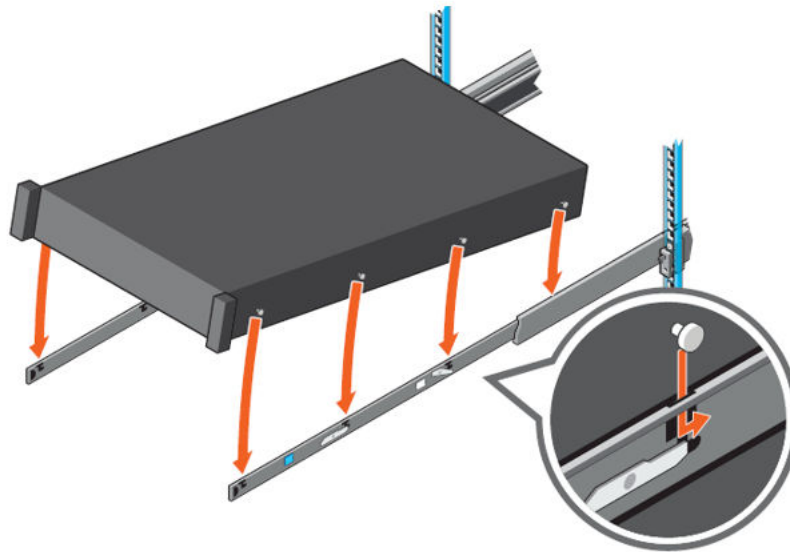
### Installing system into the rack (option A: Drop-In)

1. Pull the inner rails out of the rack until they lock into place.



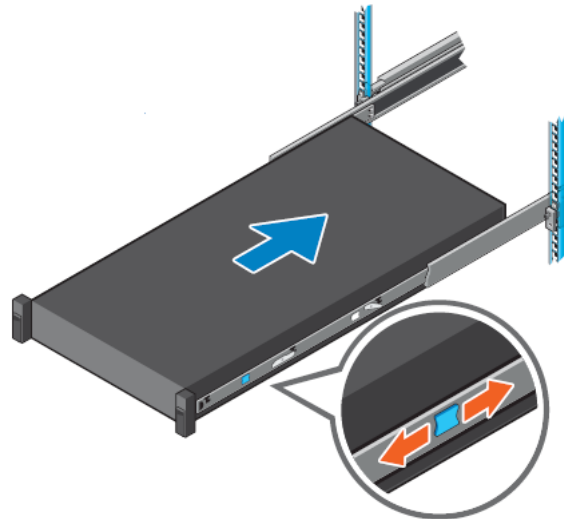
**Figure 34. Pull out inner rail**

2. Locate the rear rail standoff on each side of the system and lower them into the rear J-slots on the slide assemblies.
3. Rotate the system downward until all the rail standoffs are seated in the J-slots.



**Figure 35. Rail standoffs seated in J-slots**

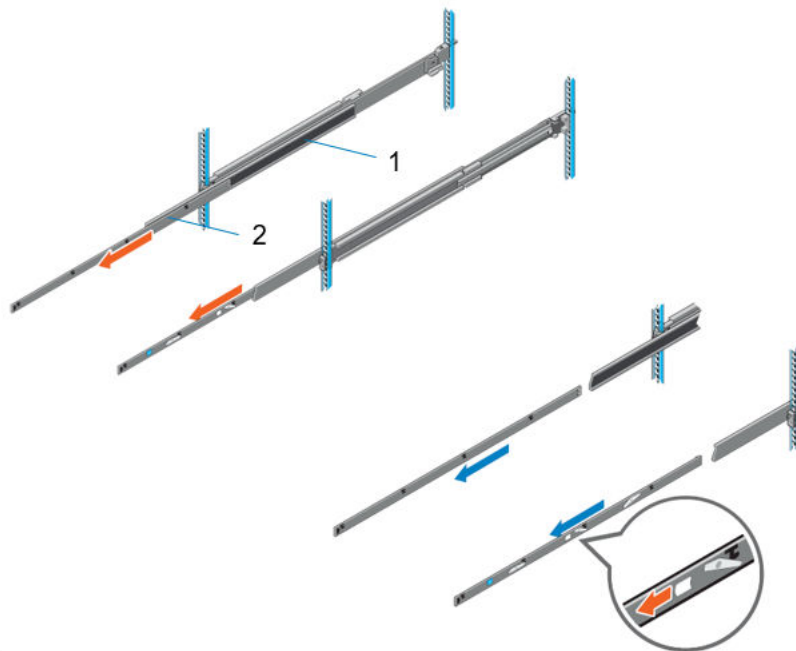
4. Push the system inward until the lock levers click into place.
5. Pull the blue side release lock tabs forward or backward on both rails and slide the system into the rack until the system is in the rack.



**Figure 36. Slide system into the rack**

## Installing the system into the rack (option B: Stab-In)

1. Pull the intermediate rails out of the rack until they lock into place.
2. Release the inner rail lock by pulling forward on the white tabs and sliding the inner rail out of the intermediate rails.

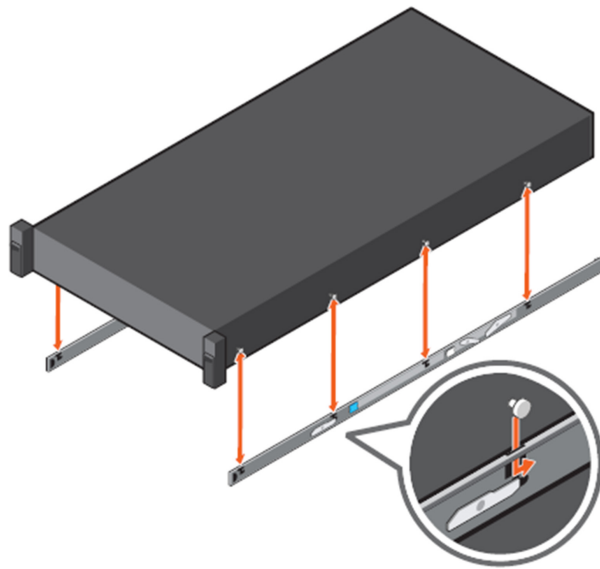


**Figure 37. Pull out the intermediate rail**

**Table 30. Rail component label**

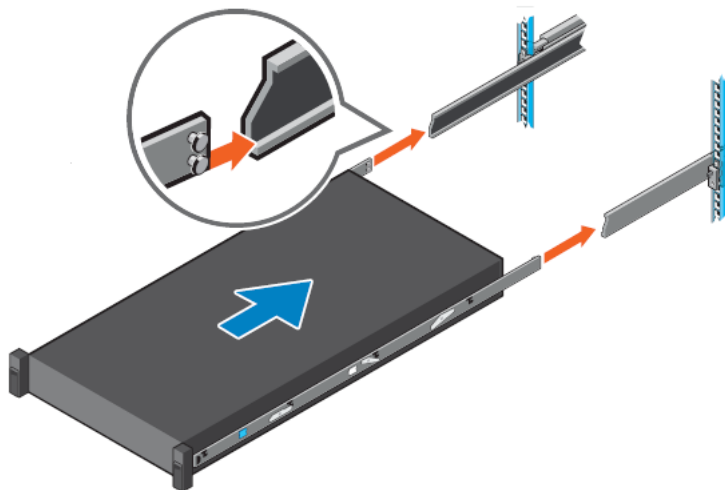
Number	Component
1	Intermediate rail
2	Inner rail

3. Attach the inner rails to the sides of the system by aligning the J-slots on the rail with the standoffs on the system and sliding forward on the system until they lock into place.



**Figure 38. Attach the inner rails to the system**

4. With the intermediate rails extended, install the system into the extended rails.



**Figure 39. Install system into the extended rails**

5. Pull blue slide release lock tabs forward or backward on both rails, and slide the system into the rack.

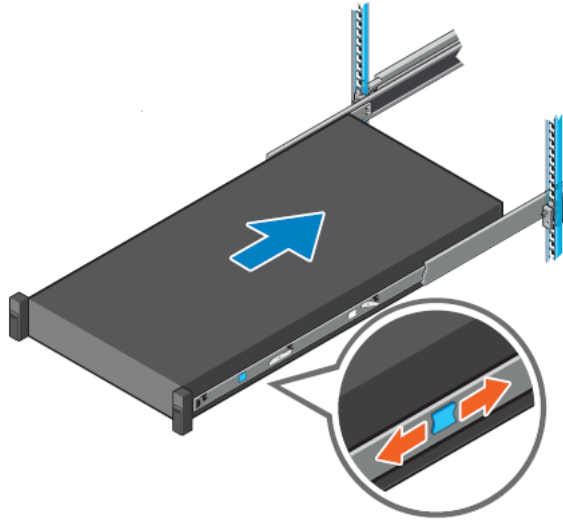


Figure 40. Slide system into the rack

# Supported operating systems

The PowerEdge R760xs system supports the following operating systems:

- Canonical Ubuntu Server LTS
- Microsoft Windows Server with Hyper-V
- Red Hat Enterprise Linux
- SUSE Linux Enterprise Server
- VMware vSAN/ESXi

For more information, go to [OS support](#).

# Dell Systems Management

Dell delivers management solutions that help IT administrators effectively deploy, update, monitor, and manage IT assets. Dell solutions and tools enable you to quickly respond to problems by helping them to manage Dell servers efficiently; in physical, virtual, local, and remote environments; all without the need to install an agent in the operating system.

The OpenManage portfolio includes:

- Innovative embedded management tools - integrated Dell Remote Access Controller (iDRAC)
- Consoles - OpenManage Enterprise
- Extensible with plug-ins - OpenManage Power Manager
- Update tools - Repository Manager

Dell has developed comprehensive systems management solutions that are based on open standards and has integrated with management consoles from partners such as Microsoft and VMware, allowing advanced management of Dell servers. Dell management capabilities extend to offerings from the industry's top systems management vendors and frameworks such as Ansible, Splunk, and ServiceNow. OpenManage tools automate the full span of server life cycle management activities along with powerful RESTful APIs to script or integrate with your choice of frameworks.

For more information about the entire OpenManage portfolio, see:

- The latest [Dell Systems Management Overview Guide](#).

## Topics:

- [Integrated Dell Remote Access Controller \(iDRAC\)](#)
- [Systems Management software support matrix](#)

## Integrated Dell Remote Access Controller (iDRAC)

iDRAC9 delivers advanced, agent-free, local and remote server administration. Embedded in every PowerEdge server, iDRAC9 provides a secure means to automate a multitude of common management tasks. Because iDRAC is embedded within every PowerEdge server, there is no additional software to install; just plug in power and network cables, and iDRAC is ready to go. Even before installing an operating system (operating system) or hypervisor, IT administrators have a complete set of server management features at their fingertips.

With iDRAC9 in-place across the Dell PowerEdge portfolio, the same IT administration techniques and tools can be applied throughout. This consistent management platform allows easy scaling of PowerEdge servers as an organization's infrastructure grows. Customers can use the iDRAC RESTful API for the latest in scalable administration methods of PowerEdge servers. With this API, iDRAC enables support for the Redfish standard and enhances it with Dell extensions to optimize at-scale management of PowerEdge servers. By having iDRAC at the core, the entire OpenManage portfolio of Systems Management tools allows every customer to tailor an effective, affordable solution for any size environment.

Zero Touch Provisioning (ZTP) is embedded in iDRAC. ZTP - Zero Touch Provisioning is Intelligent Automation Dell's agent-free management puts IT administrators in control. Once a PowerEdge server is connected to power and networking, that system can be monitored and fully managed, whether you're standing in front of the server or remotely over a network. In fact, with no need for software agents, an IT administrator can: · Monitor · Manage · Update · Troubleshoot and remediate Dell servers. With features like zero-touch deployment and provisioning, iDRAC Group Manager, and System Lockdown, iDRAC9 is purpose-built to make server administration quick and easy. For those customers whose existing management platform utilizes in-band management, Dell does provide iDRAC Service Module, a lightweight service that can interact with both iDRAC9 and the host operating system to support legacy management platforms.

When ordered with DHCP enabled from the factory, PowerEdge servers can be automatically configured when they are initially powered up and connected to your network. This process uses profile-based configurations that ensure each server is configured per your specifications. This feature requires an iDRAC Enterprise license.

iDRAC9 offers following license tiers:

**Table 31. iDRAC9 license tiers**

License	Description
iDRAC9 Basic	<ul style="list-style-type: none"> <li>Available only on 100-500 series rack/tower</li> <li>Basic instrumentation with iDRAC web UI</li> <li>For cost conscious customers that see limited value in management</li> </ul>
iDRAC9 Express	<ul style="list-style-type: none"> <li>Default on 600+ series rack/tower, modular, and XR series</li> <li>Includes all features of Basic</li> <li>Expanded remote management and server life-cycle features</li> </ul>
iDRAC9 Enterprise	<ul style="list-style-type: none"> <li>Available as an upsell on all servers</li> <li>Includes all features of Basic and Express. Includes key features such as virtual console, AD/LDAP support, and more</li> <li>Remote presence features with advanced, Enterprise-class, management capabilities</li> </ul>
iDRAC9 Datacenter	<ul style="list-style-type: none"> <li>Available as an upsell on all servers</li> <li>Includes all features of Basic, Express, and Enterprise. Includes key features such as telemetry streaming, Thermal Manage, automated certificate management, and more</li> <li>Extended remote insight into server details, focused on high end server options, granular power, and thermal management</li> </ul>

For a full list of iDRAC features by license tier, see [Integrated Dell Remote Access Controller 9 User's Guide](#) at [Dell.com](#).

For more details on iDRAC9 including white papers and videos, see:

- [Support for Integrated Dell Remote Access Controller 9 \(iDRAC9\)](#) on the [Knowledge Base](#) page at [Dell.com](#)

## Systems Management software support matrix

**Table 32. Systems Management software support matrix**

Categories	Features	PE mainstream
Embedded Management and In-band Services	iDRAC9 (Express, Enterprise, and Datacenter licenses)	Supported
	OpenManage Mobile	Supported
	OM Server Administrator (OMSA)	Supported
	iDRAC Service Module (iSM)	Supported
	Driver Pack	Supported
Change Management	Update Tools (Repository Manager, DSU, Catalogs)	Supported
	Server Update Utility	Supported
	Lifecycle Controller Driver Pack	Supported
	Bootable ISO	Supported
Console and Plug-ins	OpenManage Enterprise	Supported
	Power Manager Plug-in	Supported
	Update Manager Plug-in	Supported
	SupportAssist Plug-in	Supported
	CloudIQ	Supported
Integrations and connections	OM Integration with VMware Vcenter/vROps	Supported
	OM Integration with Microsoft System Center (OMIMSC)	Supported
	Integrations with Microsoft System Center and Windows Admin Center (WAC)	Supported

**Table 32. Systems Management software support matrix (continued)**

<b>Categories</b>	<b>Features</b>	<b>PE mainstream</b>
	ServiceNow	Supported
	Ansible	Supported
	Third-party Connectors (Nagios, Tivoli, Microfocus)	Supported
Security	Secure Enterprise Key Management	Supported
	Secure Component Verification	Supported
Standard operating system	Red Hat Enterprise Linux, SUSE, Windows Server 2019 or 2022, Ubuntu, CentOS	Supported (Tier-1)

## Appendix B. Standards compliance

The system conforms to the following industry standards.

**Table 33. Industry standard documents**

Standard	URL for information and specifications
<b>ACPI</b> Advance Configuration and Power Interface Specification, v6.4	<a href="#">Uefi specifications and tools</a>
<b>Ethernet</b> IEEE Std 802.3-2022	<a href="#">ieee standards</a>
<b>MSFT WHQL</b> Microsoft Windows Hardware Quality Labs	<a href="https://microsoft.com/whdc/system/platform/pcdesign/desguide/serverdg.msp">microsoft.com/whdc/system/platform/pcdesign/desguide/serverdg.msp</a>
<b>IPMI</b> Intelligent Platform Management Interface, v2.0	<a href="https://intel.com/design/servers/ipmi">intel.com/design/servers/ipmi</a>
<b>DDR5 Memory</b> DDR5 SDRAM Specification	<a href="https://jedec.org/standards-documents/docs/jesd79-4.pdf">jedec.org/standards-documents/docs/jesd79-4.pdf</a>
<b>PCI Express</b> PCI Express Base Specification, v5.0	<a href="https://pcisig.com/specifications/pciexpress">pcisig.com/specifications/pciexpress</a>
<b>PMBus</b> Power System Management Protocol Specification, v1.2	<a href="#">pmbus specification and revisions</a>
<b>SAS</b> Serial Attached SCSI, 3 (SAS-3) (T10/INCITS 519)	<a href="#">SCSI storage interfaces information</a>
<b>SATA</b> Serial ATA Rev. 3.3	<a href="https://sata-io.org">sata-io.org</a> page
<b>SMBIOS</b> System Management BIOS Reference Specification, v3.3.0	<a href="#">BIOS reference specification page</a>
<b>TPM</b> Trusted Platform Module Specification, v1.2 and v2.0	<a href="https://trustedcomputinggroup.org">trustedcomputinggroup.org</a> page
<b>UEFI</b> Unified Extensible Firmware Interface Specification, v2.7	<a href="#">UEFIF specifications</a>
<b>PI</b> Platform Initialization Specification, v1.7	
<b>USB</b> Universal Serial Bus v2.0 and SuperSpeed v3.0 (USB 3.1 Gen1)	USB Implementers Forum, Inc. <a href="#">USB document library</a>
<b>NVMe</b> Express Base Specification. Revision 2.0c	<a href="#">NVME specifications</a>
<b>NVMe</b> Command Set Specifications	
1. NVMe Express NVM Command Set Specification. Revision 1.1c	
2. NVMe Express Zoned Namespaces Command Set. Revision 1.0c	
3. NVMe Express® Key Value Command Set. Revision 1.0c	
<b>NVMe</b> Transport Specifications	
1. NVMe Express over PCIe Transport. Revision 1.0c	
2. NVMe Express RDMA Transport Revision. 1.0b	
3. NVMe Express TCP Transport. Revision 1.0c	
<b>NVMe</b> NVMe Express Management Interface. Revision 1.2c	
<b>NVMe</b> NVMe Boot Specification. Revision 1.0	

## Appendix B: Additional specifications

### Topics:

- Chassis dimensions
- System weight
- Video specifications
- USB ports specifications
- Environmental specifications

### Chassis dimensions

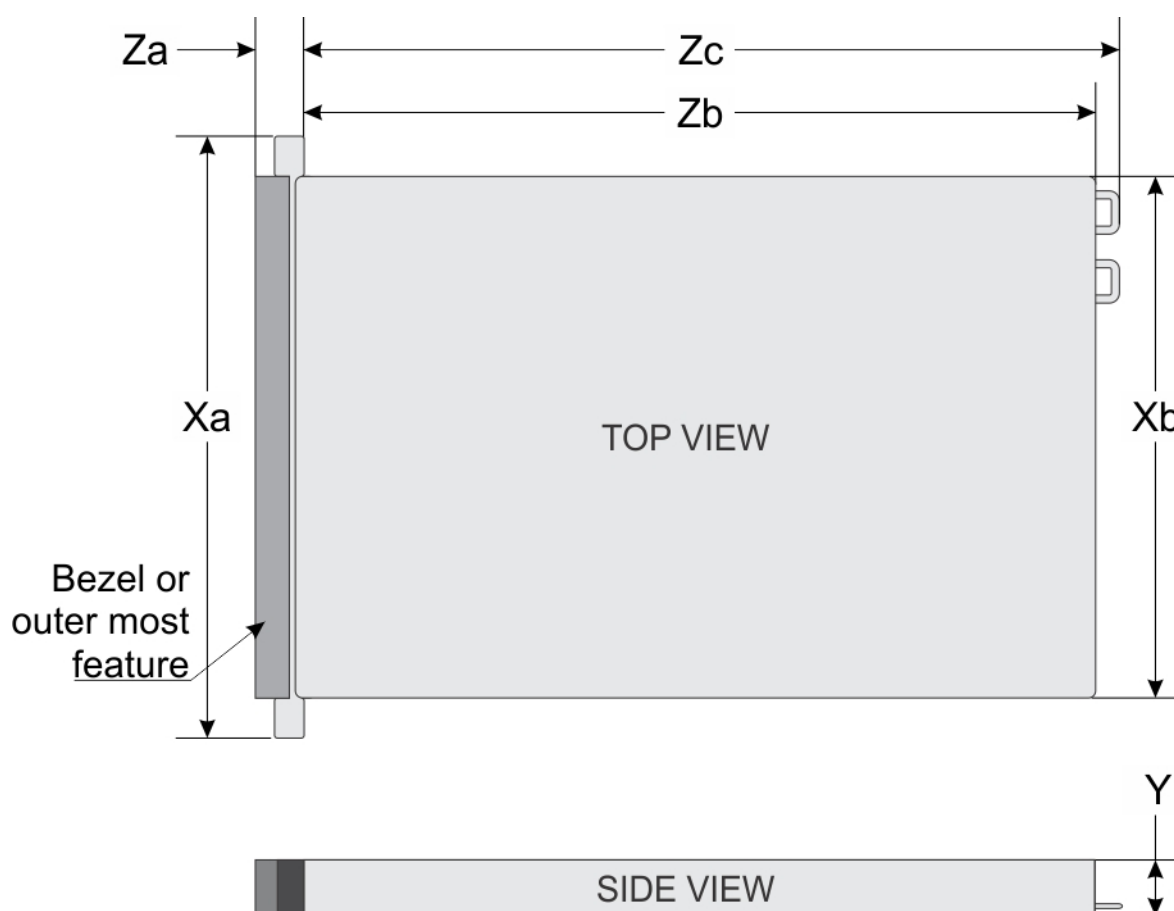


Figure 41. Chassis dimensions

Table 34. PowerEdge R760xs chassis dimensions

Xa	Xb	Y	Za	Zb	Zc
482.0 mm (18.97 inches)	434.0 mm (17.08 inches)	86.8 mm (3.41 inches)	22.0 mm (0.86 inches) Without bezel	677.44 mm (26.67 inches) Ear to L bracket housing	685.78 mm (26.99 inches) Ear to PSU handle without velcro strap

**Table 34. PowerEdge R760xs chassis dimensions**

Xa	Xb	Y	Za	Zb	Zc
			35.84 mm (1.41 inches) With bezel	650.24 mm (25.6 inches) Ear to PSU surface	

**NOTE:** Zb is the nominal rear wall external surface where the system board I/O connectors reside.

## System weight

**Table 35. PowerEdge R760xs systemweight**

System configuration	Maximum weight (with all drives/SSDs/bezel)
16+8 x 2.5-inch	25.92 kg (57.14 lb)
16 x 2.5-inch	24.58 kg (54.18 lb)
12 x 3.5-inch	28.82 kg (63.53 lb)
8 x 3.5-inch	25.84 kg (54.96 lb)
8 x 2.5-inch	21.56 kg (47.53 lb)
No backplane configuration	19.40 kg (42.76 lb)

## Video specifications

The PowerEdge R760xs system supports integrated Matrox G200 graphics controller with 16 MB of video frame buffer.

**Table 36. Supported video resolution options for the system**

Resolution	Refresh rate (Hz)	Color depth (bits)
1024 x 768	60	8, 16, 32
1280 x 800	60	8, 16, 32
1280 x 1024	60	8, 16, 32
1360 x 768	60	8, 16, 32
1440 x 900	60	8, 16, 32
1600 x 900	60	8, 16, 32
1600 x 1200	60	8, 16, 32
1680 x 1050	60	8, 16, 32
1920 x 1080	60	8, 16, 32
1920 x 1200	60	8, 16, 32

# USB ports specifications

**Table 37. PowerEdge R760xs USB specifications**

Front		Rear		Internal (Optional)	
USB port type	No. of ports	USB port type	No. of ports	USB port type	No. of ports
USB 2.0-compliant port	One	USB 2.0-compliant port	One	Internal USB 3.0-compliant port	One
iDRAC Direct port (Micro-AB USB 2.0-compliant port)	One	USB 3.0-compliant port	One		

- NOTE:** The micro USB 2.0 compliant port can only be used as an iDRAC Direct or a management port.
- NOTE:** The USB 2.0 specifications provide a 5 V supply on a single wire to power connected USB devices. A unit load is defined as 100 mA in USB 2.0, and 150 mA in USB 3.0. A device may draw a maximum of 5 unit loads (500 mA) from a port in USB 2.0; 6 (900 mA) in USB 3.0.
- NOTE:** The USB 2.0 interface can provide power to low-power peripherals but must adhere to USB specification. An external power source is required for higher-power peripherals to function, such as external CD/DVD Drives.

# Environmental specifications

- NOTE:** For additional information about environmental certifications, see the Product Environmental Datasheet that are located with the Documentation on [Dell Support](#) page.

**Table 38. Continuous Operation Specifications for ASHRAE A2**

Temperature, humidity and, operational altitude	Allowable continuous operations
Temperature range for altitudes <= 900 m (<= 2953 ft)	10–35°C (50–95°F) with no direct sunlight on the equipment
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 80% RH with 21°C (69.8°F) maximum dew point
Operational altitude derating	Maximum temperature is reduced by 1°C/300 m (1.8°F/984 Ft) above 900 m (2953 Ft)

**Table 39. Continuous Operation Specifications for ASHRAE A3**

Temperature, humidity and, operational altitude	Allowable continuous operations
Temperature range for altitudes <= 900 m (<= 2953 ft)	5–40°C (41–104°F) with no direct sunlight on the equipment
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 85% RH with 24°C (75.2°F) maximum dew point
Operational altitude derating	Maximum temperature is reduced by 1°C/175 m (1.8°F/574 Ft) above 900 m (2953 Ft)

**Table 40. Continuous Operation Specifications for ASHRAE A4**

Temperature, humidity and, operational altitude	Allowable continuous operations
Temperature range for altitudes <= 900 m (<= 2953 ft)	5–45°C (41–113°F) with no direct sunlight on the equipment

**Table 40. Continuous Operation Specifications for ASHRAE A4 (continued)**

Temperature, humidity and, operational altitude	Allowable continuous operations
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 90% RH with 24°C (75.2°F) maximum dew point
Operational altitude derating	Maximum temperature is reduced by 1°C/125 m (1.8°F/410 Ft) above 900 m (2953 Ft)

**Table 41. Continuous Operation Specifications for Rugged Environment**

Temperature, humidity and, operational altitude	Allowable continuous operations
Temperature range for altitudes <= 900 m (<= 2953 ft)	5–45°C (41–113°F) with no direct sunlight on the equipment
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 90% RH with 24°C (75.2°F) maximum dew point
Operational altitude derating	Maximum temperature is reduced by 1°C/125 m (1.8°F/410 Ft) above 900 m (2953 Ft)

**Table 42. Common Environmental Specifications for ASHRAE A2, A3, A4, and Rugged**

Temperature, humidity and, operational altitude	Allowable continuous operations
Maximum temperature gradient (applies to both operation and non-operation)	20°C in an hour* (36°F in an hour) and 5°C in 15 minutes (9°F in 15 minutes), 5°C in an hour* (9°F in an hour) for tape <i>i</i> <b>NOTE:</b> * - Per ASHRAE thermal guidelines for tape hardware, these are not instantaneous rates of temperature change.
Non-operational temperature limits	-40°C to 65°C (-104°F to 149°F)
Non-operational humidity limits	5% to 95% RH with 27°C (80.6°F) maximum dew point
Maximum non-operational altitude	12,000 meters (39,370 feet)
Maximum operational altitude	3,048 meters (10,000 feet)

**Table 43. Maximum vibration specifications**

Maximum vibration	Specifications
Operating	0.21 G <sub>rms</sub> at 5 Hz to 500 Hz for 10 minutes (all operation orientations)
Storage	1.88 G <sub>rms</sub> at 10 Hz to 500 Hz for 15 minutes (all six sides tested)

**Table 44. Maximum shock pulse specifications**

Maximum shock pulse	Specifications
Operating	Six consecutively performed shock pulses in the positive and negative x, y, and z axis of 6 G for up to 11 ms.
Storage	Six consecutively performed shock pulses in the positive and negative x, y, and z axis (one pulse on each side of the system) of 71 G for up to 2 ms.

The following table defines the limitations that help avoid any equipment damage or failure from particulates and gaseous contamination. If the levels of particulate or gaseous pollution exceed the specified limitations and result in equipment damage or failure, you may need to rectify the environmental conditions. Re-mediation of environmental conditions is the responsibility of the customer.

**Table 45. Particulate and gaseous contamination specifications**

Particulate contamination	Specifications
Air filtration	Data center air filtration as defined by ISO Class 8 per ISO 14644-1 with a 95% upper confidence limit. <i>i</i> <b>NOTE:</b> The ISO Class 8 condition applies to data center environments only. This air filtration requirement does not apply to IT equipment designed to be used outside a data center, in environments such as an office or factory floor. <i>i</i> <b>NOTE:</b> Air entering the data center must have MERV11 or MERV13 filtration.
Conductive dust	Air must be free of conductive dust zinc whiskers, or other conductive particles. <i>i</i> <b>NOTE:</b> This condition applies to data center and non-data center environments.
Corrosive dust	Air must be free of corrosive dust. Residual dust present in the air must have a deliquescent point less than 60% relative humidity. <i>i</i> <b>NOTE:</b> This condition applies to data center and non-data center environments.

**Table 46. Gaseous contamination specifications**

Gaseous contamination	Specification
Copper coupon corrosion rate	<300A/month per class G1 as defines by ANSI/ISA71.04-2013
Silver coupon corrosion rate	<200A/month as defined by ANSI/ISA71.04-2013

## Thermal restriction matrix

**Table 47. Processor and heat sink matrix**

Heat sink	Processor TDP
STD HSK	< 185 W CPU SKUs
HPR HSK	185 W-250 W CPU SKUs (12 x 3.5-inch drive configuration not supported)
	125W-250W CPU SKUs (12 x 3.5-inch drive configuration supported)

**Table 48. Label reference**

Label	Description
STD	Standard
HPR (Silver)	High Performance Silver (HPR) fan
HPR (Gold)	High Performance Gold (VHP) fan
HSK	Heat sink

*i* **NOTE:** The ambient temperature of the configuration is determined by the critical component in that configuration. For example, if the processor's supported ambient temperature is 35°C, the DIMM is 35°C, and the GPU is 30°C, the combined configuration can only support 30°C.

**Table 49. Supported ambient temperature for processors for R760xs**

<b>R760xs</b>										
<b>configuration</b>			<b>No backplane</b>	<b>8 x 3.5-inch SAS configuration</b>	<b>12 x 3.5-inch SAS configuration</b>	<b>12 x 3.5-inch configuration with rear drive module</b>	<b>8 x 2.5-inch SAS configuration</b>	<b>8 x 2.5-inch NVMe configuration</b>	<b>16 x 2.5-inch SAS configuration</b>	<b>16 x 2.5-inch + 8 x 2.5-inch NVMe configuration</b>
EMR MCC CPU	4514Y	150 W	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
	5512U	185 W	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
	6526Y/6534	195 W	35°C	35°C	35°C	35°C	35°C	35°C	35°C	35°C
	6548Y+/ 6542Y/6548N	250 W	35°C	35°C	30°C	30°C	35°C	35°C	35°C	35°C
SPR LCC CPU	4509Y	125 W	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
	4510	150 W	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
SPR MCC CPU	3408U	125 W	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
	5416S/ 4410T/ 4410Y/5415+	150 W	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
	4416	165 W	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
	5418Y/ 5412U/ 6426Y/ 4516Y+	185 W	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
	5420+/ 6438Y+/ 5520+	205 W	35°C	35°C	35°C	35°C	35°C	35°C	35°C	35°C
	6448Y/6442Y	225 W	35°C	35°C	35°C	35°C	35°C	35°C	35°C	35°C
	6414U	250 W	35°C	35°C	30°C	30°C	35°C	35°C	35°C	35°C
Memory	96 GB RDIMM 5200	8.1 W, 1DPC	35°C	35°C	30°C	30°C	35°C	35°C	35°C	35°C
	64 GB RDIMM 5200	7.7 W, 1DPC	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
	32 GB RDIMM 5200	5.1 W, 1DPC	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
	64 GB RDIMM 4800	12 W, 1DPC	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
	32 GB RDIMM 4800	10 W, 1DPC	45°C	40°C	35°C	35°C	40°C	40°C	40°C	40°C
PCIe			45°C	40°C	35°C <sup>1</sup>	35°C <sup>1</sup>	40°C	40°C	40°C	40°C
A2 GPU <sup>6</sup>			35°C	30°C	Not supported	Not supported	35°C	35°C	30°C	30°C
OCP			45°C	40°C	35°C <sup>2</sup>	35°C <sup>2</sup>	40°C	40°C	40°C	40°C
BOSS			35°C	35°C	35°C	35°C	35°C	35°C	35°C	35°C

**NOTE:**

1. Max supported thermal tier of PCIe card is Tier 5.
2. Max supported thermal tier of OCP is Tier 5.
3. HPR Sliver fan is required from fan zone 2 to fan zone 6 for 8 x 2.5-inch NVMe, 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe, 12 x 3.5-inch drives or GPU configurations.
4. Optional fan zone 1 has to be populated with HPR Gold fan is for BOSS, GPU or rear drive module populations.
5. PCIe slot priority of Nvidia A2 GPU is constrained on slot #3, #4, #6.
6. HPR heatsink is required for ≥ 185 W CPUs, 12 x 3.5-inch drives or 12 x 3.5-inch drives with rear storage module configurations.
7. DIMM blank is required for 12 x 3.5-inch SAS/SATA with rear storage module.
8. Fan blank is required on fan zone 1 when no fan population.
9. OCP shroud is required for OCP card population without PCIe riser module installed.
10. CPU blank is required for single processor configuration.
11. Rear drive module does not support Kioxia CM6 series, Samsung PM1735 series, Hynix PE8010/PE8110 ≥ 7.68 TB, Samsung PM1733a > 1.92 TB, Samsung PM1735a > 1.6 TB and Redtail NVMe drive.

**NOTE:** The fan speed in the 3.5-inch chassis is limited to 90% due to the drive dynamic profile.

**Table 50. Fan population rule for R760xs**

configuration	No backplane	8 x 3.5-inch SAS	12 x 3.5-inch SAS	8 x 2.5-inch SAS	8 x 2.5-inch NVMe	16 x 2.5-inch SAS	24 x 2.5-inch (16 x 2.5-inch + 8 x 2.5-inch NVMe)
Optional HW							
Default	Fan 2 to Fan 6 with STD fan	Fan 2 to Fan 6 with STD fan	Fan 2 to Fan 6 with HPR Silver fan	Fan 2 to Fan 6 with STD fan	Fan 2 to Fan 6 with HPR Silver fan	Fan 2 to Fan 6 with STD fan	Fan 2 to Fan 6 with HPR Silver fan
Rear Module	Not supported	Not supported	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with HPR Silver fan	Not supported	Not supported	Not supported	Not supported
BOSS N1	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with STD fan	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with STD fan	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with HPR Silver fan	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with STD fan	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with HPR Silver fan	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with STD fan	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with HPR Silver fan
GPU	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with HPR Silver fan	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with HPR Silver fan	Not supported	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with HPR Silver fan	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with HPR Silver fan	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with HPR Silver fan	Fan 1 with HPR Gold fan Fan 2 to Fan 6 with HPR Silver fan

## Thermal Restrictions for PCIe adapter NIC and other network cards with iDRAC

- Cannot support PCIe cards with the cooling requirement more than 300LFM at 55C in a 12 x 3.5-inch SAS/SATA configuration.
- Solarflare Melrose DP 25 GBE SFP28 (TTKWY) not supported with 12 x 3.5-inch SAS/SATA configuration.
- 100 Gb network adapter or 100 Gb OCP is not supported in the 12 x 3.5-inch SAS/SATA configuration.
- Few 25 GB OCP cards with the cooling requirement more than 250LFM at 55C (3Y64D/4TRD3 / GGGDF/R1KTR / Y4VV5) is not supported in 12x3.5" SAS/SATA configuration.

- The 12 x 3.5-inch SAS/SATA configuration requires the optical transceiver with higher temperature spec ( $\geq 85^{\circ}\text{C}$ ) to support (M14MK / N8TDR).
- Quad port OCP (3Y64D/Y4VV5) requires the optical transceiver with higher temperature spec ( $\geq 85^{\circ}\text{C}$ ) to support (M14MK).
- 100 Gb network adapter cannot support the transceivers as 14NV5/9JJK2 / QSFP56 (MFS1S00-VxxxE/HxxxE).
- The H965e is limited to populate in PCI slot 3 in a 12 x 3.5-inch SAS/SATA configuration.
- Mellanox CX7 NDR200 card has few limitations of PCI slot locations.

**Table 51. Mellanox CX7 NDR200 slot location limitations**

Storage configuration	Slots on 3.5-inch configuration	Slots on 2.5-inch configuration
Gen5 PCIe slot support for CX7 NDR200	3, 4	3, 4
Gen4 PCIe slot support for CX7 NDR200	6	5, 6

## Thermal restrictions for extended ambient support (ASHRAE A3/A4)

- Two PSUs are required in redundant mode. Single PSU failure is not supported.
- 12 x 3.5-inch SAS/SATA configuration is not supported.
- BOSS(M.2) module is not supported.
- CPU TDP  $> 185\text{ W}$  is not supported.
- PCIe card TDP  $> 25\text{ W}$  is not supported.
- OCP cards with transmission rate higher than 25 GB is not supported.
- OCP transceiver spec  $\leq 75^{\circ}\text{C}$  is not supported.
- 8 x 3.5-inch SAS/SATA, 8 x 2.5-inch SAS/SATA, 8 x 2.5-inch NVMe, 16 x 2.5-inch SAS/SATA, 16 x 2.5-inch SAS/SATA + 8x 2.5-inch NVMe configurations are limited to support A3.
- 128 GB+ memory is not supported .
- The rear drive is not supported.

## Appendix C Additional resources

**Table 52. Additional resources**

Resource	Description of contents	Location
Installation and Service Manual	This manual, available in PDF format, provides the following information: <ul style="list-style-type: none"> <li>• Chassis features</li> <li>• System Setup program</li> <li>• System indicator codes</li> <li>• System BIOS</li> <li>• Remove and replace procedures</li> <li>• Diagnostics</li> <li>• Jumpers and connectors</li> </ul>	<a href="https://Dell.com/Support/Manuals">Dell.com/Support/Manuals</a>
Getting Started Guide	This guide ships with the system, and is also available in PDF format. This guide provides the following information: <ul style="list-style-type: none"> <li>• Initial setup steps</li> </ul>	<a href="https://Dell.com/Support/Manuals">Dell.com/Support/Manuals</a>
Rack Installation Guide	This document ships with the rack kits, and provides instructions for installing a server in a rack.	<a href="https://Dell.com/Support/Manuals">Dell.com/Support/Manuals</a>
System Information Label	The system information label documents the system board layout and system jumper settings. Text is minimized due to space limitations and translation considerations. The label size is standardized across platforms.	Inside the system chassis cover
QR code for system resources	This code on the chassis can be scanned by a phone application to access additional information and resources for the server, including videos, reference materials, service tag information, and Dell contact information.	Inside the system chassis cover
Enterprise Infrastructure Planning Tool (EIPT)	The Dell online EIPT enables easier and more meaningful estimates to help you determine the most efficient configuration possible. Use EIPT to calculate the power consumption of your hardware, power infrastructure, and storage.	<a href="https://Dell.com/calc">Dell.com/calc</a>

### Topics:

- [Documentation](#)
- [Customer kits](#)

# Documentation

This section provides information about the documentation resources for your system.

**Table 53. Documentation resources**

Document	Location
Factory Configuration Matrix	<a href="#">Sales Portal</a>
SPM (Slot Priority Matrix)	<a href="#">Sales Portal</a>
NDA Deck	<a href="#">Sales Portal</a>
Installation and Service Manual (ISM)	<a href="#">PowerEdge Manuals</a>
Field Service Manual (FSM)	<a href="#">PowerEdge Manuals</a> > Sign In
Technical Guide	<a href="#">Dell Support</a> page > <b>Products</b> > <b>IT infrastructure</b> > <b>Products</b> > > <b>Servers</b>
Spec Sheet	<a href="#">Dell Support</a> page > <b>Products</b> > <b>IT infrastructure</b> > <b>Products</b> > <b>Servers</b>

## Customer kits


### Dell Upgrades

It is not always possible to plan for new applications, future workloads, and business needs. Unleash the full power of your Dell Technologies Infrastructure. When budget does not permit the purchase of new servers, Dell Upgrades is a cost-effective method to repurpose and unleash the full power of existing server, storage, and networking infrastructure.




- Protect your mission-critical operations by using only genuine Dell OEM-validated Upgrades and the technical expertise of Dell ProSupport
- Flex and scale existing infrastructure by upgrading, adding memory or storage drives to cost-effectively and quickly meet new workloads and demands
- Dell Upgrades are the same peripheral commodities that your customer may improve or maintain their server after the initial point of sale

### Upgrades portfolio


**Table 54. Upgrade category**

Dell Upgrade Category	Sample Picture	Dell Upgrade Category Offerings
<p>Memory</p> <p>Memory upgrades are essential for keeping your customers operating at peak performance as their business needs grow and their workloads increase. We tend to see strong demand for server memory because it is the easiest and most cost-effective way to improve system performance.</p>		<p>DDR5 5600 MT/s and 4800 MT/s</p>

**Table 54. Upgrade category (continued)**

Dell Upgrade Category	Sample Picture	Dell Upgrade Category Offerings
<p>Storage</p> <p>Dell offers both solid-state drive and hard disk drive storage options for enterprise systems with SATA, SAS or NVMe interfaces. SSDs excel in speed, high-performance I/O requirements, and high reliability due to the lack of spinning disks. Hard Disk Drives (HDDs) store data on spinning disks and offer value for the amount of data storage for the price.</p> <p>Dell offers both solid-state drive and hard disk drive storage options for enterprise systems with SATA, SAS interfaces. SSDs excel in speed, high-performance I/O requirements, and high reliability due to the lack of spinning disks. Hard Disk Drives (HDDs) store data on spinning disks and offer value for the amount of data storage for the price.</p>		<p>HDD: SATA, SAS interface</p> <p>SSD: SATA, SAS, PCI</p> <p>NVMe interface Tape Drive or Media</p>
<p>Processor</p> <p>Processor upgrades help customers perform and accomplish more tasks overall, saving them valuable time. Our processor upgrades include Intel® Xeon® Scalable processors to meet your customers workload needs with increased cores and improved security.</p>		<p>Processors (Intel)</p> <p>Heat sinks</p>
<p>Networking and Optics</p> <p>Our networking and optics components—network interface cards, transceivers, optical cables, and more—are key in today’s data center environment, helping customers to improve bandwidth to better manage increase in workloads, devices, users, and interconnected systems.</p>		<p>Network cards</p> <p>Transceivers (Optics)</p>

**Table 54. Upgrade category (continued)**

Dell Upgrade Category	Sample Picture	Dell Upgrade Category Offerings
<p>Accessories: Dell sells accessories like power supplies, cables and power cables, bezels, controller cards, GPU, PERC and other components to complete the Dell Upgrades portfolio and redundancies.</p>		<ul style="list-style-type: none"> <li>Controller cards</li> <li>Power supplies</li> <li>Cables</li> <li>Rail kits</li> <li>Bezels</li> <li>Power cords</li> <li>GPU</li> <li>PERC</li> <li>BOSS</li> <li>Power cords</li> <li>Cable Management Arm (CAM)</li> <li>Fans</li> <li>Serial board</li> <li>Internal USB</li> </ul>

## Upgrades reference links

- [Main Upgrades Page](#)
- [Customer Kit Selector](#)
- [Dell Parts Finder Tool](#) (Customer Facing Tool)

## Appendix D: Service and support

### Topics:

- [Why attach service contracts](#)
- [ProSupport Infrastructure Suite](#)
- [Specialty Support Services](#)
- [ProDeploy Infrastructure Suite](#)
- [Supplemental Deployment Services](#)
- [Unique Deployment Scenarios](#)
- [DAY 2 – Automation Services with Ansible](#)
- [Dell Technologies Consulting Services](#)

### Why attach service contracts

Dell PowerEdge servers include a standard hardware warranty that highlights our commitment to product quality by guaranteeing repair or replacement of defective components. While industry-leading, our warranties are limited to 1 or 3 years, depending on model, and do not cover software assistance. Call records show that customers are most often seeking Dell technical support for software related issues like configuration guidance, troubleshooting, upgrade assistance or performance tuning. Encourage customers to purchase ProSupport service contracts to supplement warranty coverage and ensure optimal support for both hardware and software. ProSupport provides a complete hardware guarantee beyond the original warranty period.

### ProSupport Infrastructure Suite

ProSupport Infrastructure Suite is a set of support services that enable customers to build the solution that is right for their organization. It is an industry-leading, enterprise-class support that aligns with the criticality of your systems, the complexity of your environment, and the allocation of your IT resources.

Figure 42. ProSupport Enterprise Suite

	Basic Hardware Support <sup>1</sup>	ProSupport	BEST ProSupport Plus
<b>Outcome Assistance and Advocacy</b> via assigned Technical Customer Success Manager ⓘ			
Enjoy a frictionless customer experience with cross-functional lifecycle management aligned to your goals			✓
Accelerate time-to-value through onboarding assistance, education and success planning			✓
Turn challenges into opportunities with actionable strategies powered by data and AI-driven analytics			✓
Ensure coverage continuity while preparing to scale for future success			✓
<b>Proactive Monitoring &amp; Actionable Insights</b> via Dell's connectivity solutions and tools			
Quickly visualize performance through a current system health score		✓	✓
Cybersecurity monitoring and mitigation recommendations provide another layer of protection		✓	✓
Predictive performance and capacity analysis address bottlenecks		✓	✓
Prevent or plan for downtime with predictive hardware anomaly detection		✓	✓
Energy consumption and carbon footprint forecasting support sustainability and stewardship initiatives		✓	✓
Get ahead of problems with proactive issue detection with automated case creation	✓	✓	✓
Streamline internal IT efforts with efficient service request and escalation management tools	✓	✓	✓
Minimize disruptions by self-dispatching eligible parts	✓	✓	✓
<b>Support Essentials</b>			
Receive an assigned incident manager for Sev 1 issues who will work your issue through to resolution		✓	✓
Count on Mission Critical Support during Sev 1 incidents and natural disasters ⓘ			✓
Keep systems code current and performing at peak through Proactive System Maintenance			✓
Get priority access to senior technical support engineers—skip the queues and callbacks			✓
Bringing your own software? We provide limited 3rd party software support ⓘ			✓
Choose onsite parts delivery and labor response that meets your needs	Next Business Day	NBD or 4-hour	4-hour
Select product coverage that best augments your internal resources	Hardware	Hardware & Software	Hardware & Software
Have an issue? We are here for you by phone, chat and online	Local business hours	24/7/365	24/7/365

## ProSupport Plus for Infrastructure

ProSupport Plus for Infrastructure is the ultimate solution for customers seeking preventative maintenance and optimal performance on their business-critical assets. The service caters to customers who require proactive, predictive, and personalized support for systems that manage critical business applications and workloads. When customers purchase PowerEdge server, we recommend ProSupport Plus, our proactive and preventative support service for business-critical systems. ProSupport Plus provides all the benefits of ProSupport, including the following “Top five reasons to buy ProSupport Plus (PSP)”

- 1. Priority access to specialized support experts:** Immediate advanced troubleshooting from an engineer that understands Dell infrastructure solutions.
- 2. Mission Critical Support:** When critical (Severity 1) support issues happen, the customer is assured that we do all that we can to get them back up and running as quickly as possible.
- 3. Technical Customer Success Manager:** A customer’s #1 support advocate, ensuring they get the best possible proactive and predictive support experience.
- 4. Systems maintenance:** On a semiannual basis, we will keep a customer’s ProSupport Plus system(s) up to date by installing the latest firmware, BIOS, and driver updates to improve performance and availability.
- 5. Third-party software support:** Dell is a customer’s single point of accountability for any eligible third-party software that is installed on their ProSupport Plus system, whether they purchased the software from us or not.

## ProSupport for Infrastructure

Comprehensive 24x7 support for hardware and software – best for production, but not critical, workloads and applications. The ProSupport service offers highly trained experts around the clock and around the globe to address IT needs. We help minimize disruptions and maximize availability of PowerEdge server workloads with:

- 24x7 support through phone, chat and online
- A central point of accountability for all hardware and software issues
- Hypervisor, operating system, and application support
- Dell security advisories

- Onsite response service levels 4 hour or Next Business Day options
- Proactive issue detection with automated case creation
- Predictive hardware anomaly detection
- Incident Manager assigned for Severity 1 cases
- Collaborative third-party support
- Access to AIOps Platforms - (MyService360, TechDirect, and CloudIQ)
- Consistent experience regardless of where customers are located or what language that they speak.

## Basic Hardware Support

Provides reactive hardware support during normal business hours, excluding local national holidays. No software support or software-related guidance. For improved levels of support, choose ProSupport or ProSupport Plus.

## Specialty Support Services

Optional specialty support services complement the ProSupport Infrastructure Suite to provide additional proficiencies that are critical for modern data center operations.

### Hardware coverage add-ons to ProSupport or ProSupport Plus

- **Keep Your Hard Drive (KYHD), Keep Your Component (KYC), or Keep Your GPU (KYGPU):**

Normally if a device fails under warranty, Dell replaces it using a one-for-one exchange process. KYHD/KYCC/KYGPU gives you the option to retain your device. It provides full control of sensitive data and minimizes security risk by letting you retain possession of failed drives, components, or GPU when receiving replacement parts without incurring additional cost.

- **Onsite Diagnosis Service:**

Ideal for sites with non-technical staff. Dell field technician performs initial troubleshooting diagnosis onsite and transfers to Dell remote engineers to resolve the issue.

- **ProSupport Add-on for HPC:**

Sold as an add-on to a ProSupport service contract, the ProSupport Add-on for HPC provides solution-aware support to cover the additional requirements that are required to maintain an HPC environment such as:

- Access to senior HPC experts
- Advanced HPC cluster assistance: Performance, interoperability, and configuration
- Enhanced HPC solution level end-to-end support
- Remote pre-support engagement with HPC Specialists during ProDeploy implementation

- **ProSupport Add-on for Telco (Respond & Restore):**

An add-on service designed for the top 31 TELCO customers globally, Respond & Restore provides direct access to Dell solution experts who specialize in TELCO carrier-grade support. This add-on also provides a hardware uptime guarantee, meaning if a system fails, Dell has it installed and operational within 4 hours for Severity 1 issues. Dell incurs penalties and fees if SLAs are not met.

### Personalized Support and Supplemental Site-wide Expertise

- **Technical Account Manager:**

Designated technology lead who monitors and manages the performance and configuration of specific technology sets.

- **Designated Remote Support:**

Personalized support expert who manages all troubleshooting and resolution of IT assets.

- **Multivendor Support Service:**

Support your third-party devices as one service plan for servers, storage, and networking (includes coverage for: Broadcom, Cisco, Fujitsu, HPE, Hitachi, Huawei, IBM, Lenovo, NetApp, Oracle, Quanta, SuperMicro and others).

## Services for large enterprises

- **ProSupport One for Data Center:**

ProSupport One for Data Center offers flexible site-wide support for large and distributed data centers with more than 1,000 assets (combined total of server, storage, networking, so forth). This offering is built on standard ProSupport features that leverage our global scale and are tailored to specific customer needs. While not for everyone, this service option offers a truly unique solution for our largest customers with the most complex environments.

- Team of assigned Services Account Managers with remote or onsite options
- Assigned technical and field engineers who are trained on the customer's environment and configurations.
- On-demand reporting and recommendations that are enabled by ProSupport AIOps tools (MyService360, TechDirect, and CloudIQ)
- Flexible onsite support and parts options that fit their operational model
- A tailored support plan and training for their operations staff

- **ProSupport One for Data Center – CSP (Cloud Serviced Provider) and AI Solution**

ProSupport One for Data Center – CSP and AI Solution is a unique offer that is designed for a limited set of Dell accounts purchasing AI computing solutions greater than 1,000 servers and \$250M in sales. PS1DC - CSP and AI improves the entire services experience combining support, deployment (rack integration), residency services, a designated support engineer, an onsite service engineer, and an onsite parts service as one holistic offer. Special pricing has been determined to compete effectively against competitors and provide the best customer experience. PS1DC for CSP and AI can only be sold with XE Servers and all networking platforms (Dell and NVIDIA). All other products would be eligible for the standard PS1DC, not this unique offer. More details on PS1DC for CSP and AI [here](#).

- **Onsite Parts Service (OPS)**

Ideal for large organizations that have their own staff to support their data center. Dell offers a service that is called Onsite Parts Service (OPS) from Dell Services. OPS manages parts inventory located at the customer's designated facility. The Logistics Online Inventory Solution (LOIS) program will use software to support the monitoring and automatic replenishment of inventory stored on the customer site. . Each replacement part would automatically initiate a replenishment of the parts inventory that is shipped the next day or delivered onsite by Dell during a regular scheduled visit (called Scheduled Onsite Service). As part of the LOIS system, customers can integrate their systems directly to Dell TechDirect using APIs to help streamline the support management process.

## End-of-Life Services

- **Post Standard Support (PSS)**

Extend service life beyond the initial seven years of ProSupport, adding up to five more additional years of hardware coverage.

- **Data Sanitization & Data Destruction**

Renders data unrecoverable on repurposed or retired products, ensuring security of sensitive data and enabling compliance and provides NIST-compliant certification.

- **Asset Recovery Services**

Recycle, resale, and disposal of hardware. Helps you securely and responsibly retire IT assets that are no longer needed while protecting both your business and the planet.

## ProDeploy Infrastructure Suite

ProDeploy Infrastructure Suite provides various deployment offerings that satisfy a customer's unique needs. It is made up of various sub-offers: Factory Configuration Services, Rack Integration, Basic Deployment, ProDeploy, ProDeploy Plus, and optionally ProDeploy FLEX which allows for some customization of the features listed.

# ProDeploy Infrastructure Suite

Versatile choices for accelerated deployments

NOTE: All XE Series servers require mandatory deployment

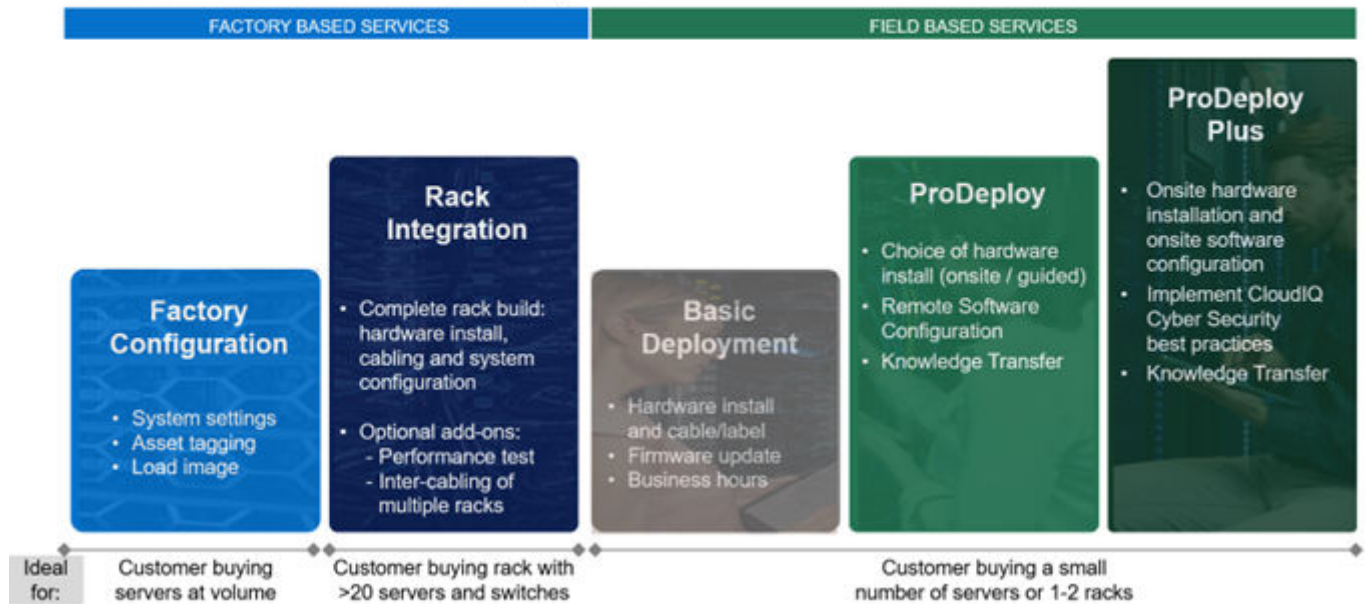


Figure 43. ProDeploy Infrastructure Suite

## Factory-based Services

Pre-configured systems or complete racks, customized prior to shipping to the customer's site.

### Customer Rack Integration or ProDeploy FLEX Rack Integration

Dell offers robust custom rack integration services through two main programs: Enterprise Rack Integration Services and Integrated Rack Scalable Systems (IRSS). These services are designed to streamline deployment, reduce complexity, and optimize performance for data centers, edge environments, and AI workloads. These factory services are purchased as a custom engagement or as ProDeploy Flex Rack Integration SKUs.

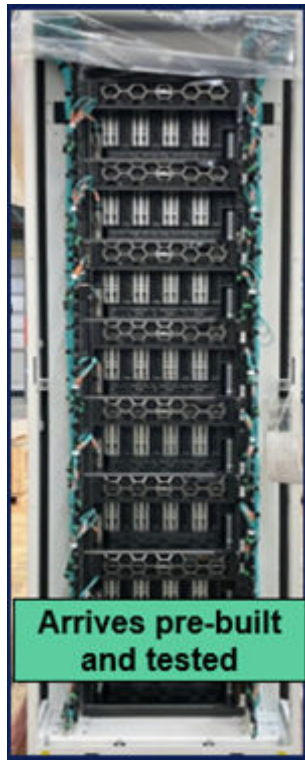


Figure 44. Pre-configured system



Figure 45. Pre-configured system

### Factory Configuration

Ideal for customers buying servers in volume and seeking pre-configuration prior to shipping such as: custom image, system settings, and asset tagging so it arrives ready to use out of the box. Furthermore, servers are packaged and bundled to meet specific shipping and distribution requirements for each customer location to facilitate the rollout process. Once the server is onsite, Dell can install and configure the server to the environment using any of the field-based deployment services outlined in the next section.

## Field-based services

Put PowerEdge servers to work faster with Dell field-based deployment services. Whether we are deploying one server to one thousand – we have you covered. Dell provides versatile delivery options to fit every budget and operating model.

- **ProDeploy Plus:** Elevate Infrastructure deployments with our most complete service from planning through onsite hardware installation and software configuration including the implementation of cybersecurity best practices. ProDeploy Plus provides the skill and scale that is needed to successfully execute demanding deployments in today's complex IT environments. The deployment starts with a site readiness review and implementation plan. Certified deployment experts perform the software configuration to include setup of leading operating systems and hypervisors. Dell will also configure PowerEdge software tools to include iDRAC and OpenManage system utilities as well as support AI/Ops platforms: MyService360, TechDirect, and

CloudIQ. Unique to ProDeploy Plus, the cybersecurity implementation helps customers understand potential security risks and make recommendations for reducing product attack surfaces. The system is tested, validated prior to completion. The customer will also receive full project documentation and knowledge transfer to complete the process.

- **ProDeploy:** ProDeploy provides remote software configuration and choice of hardware installation (onsite or guided). ProDeploy is great for customers who are price sensitive or willing to participate in some portion of the deployment to include providing remote access to their network. The ProDeploy remote software includes everything mentioned in ProDeploy Plus except it does not include the added value, cybersecurity implementation, and implementation best practices.
- **Basic Deployment:** Basic Deployment delivers worry-free professional installation by experienced technicians. This service is often sold to Competency Enabled Partners who will have Dell do the hardware installation while they complete the software configuration. Furthermore, Basic Deployment tends to be purchased by large enterprises who have smart technical staff. These companies just need Dell to install the hardware, and they will perform the software configuration. The last use case for Basic Deployment is when paired with Factory Configuration services. The servers are preconfigured in the factory, and the basic deployment service will install the system into the rack to finalize the deployment.

## ProDeploy Infrastructure Suite | Field services

		Basic Deployment	ProDeploy	ProDeploy Plus
<b>Pre-deployment</b>	Single point of contact for project management	-	●	In region
	Site readiness review and implementation planning	-	●	●
<b>Deployment</b>	Deployment service hours	Business hours	24/7	24/7
	Hardware installation options	Onsite	Onsite or guided <sup>1</sup>	Onsite
	System software installation and configuration options	-	Remote	Onsite
	Install connectivity software based on Secure Connect Gateway technology <sup>2</sup>	-	●	●
	Implement CyberSecurity best practices and policies in APEX AIOps Infrastructure Observability	-	-	●
<b>Post-deployment</b>	Deployment verification, documentation and knowledge transfer	-	●	●
	Configuration data transfer to Dell technical support	-	●	●
<b>Online collaboration</b>	Online collaborative platform in TechDirect for planning, managing and tracking delivery	-	●	●

<sup>1</sup> Choose from onsite hardware installation or a guided option including project specific instructions, documentation and live expert guidance  
<sup>2</sup> Post deployment use for intelligent, automated support & insights

Figure 46. ProDeploy Infrastructure Suite - Field services

## Supplemental Deployment Services

Additional ways to expand scope or deploy for unique scenarios.

### Two Host Adder (requires PD/PDP)

Deploying new storage, compute, or networking devices may require interconnection to other servers (also called hosts). The Dell delivery team will set up four hosts per device as part of every ProDeploy service. For example, if the customer is buying two storage arrays the ProDeploy service will automatically include connectivity of four hosts each (4x2=8 total hosts per project since there are two devices). This supplemental "Two Host Adder" service provides for the configuration of additional hosts above what is already provided as part of the ProDeploy service. In many cases, customers can work with us while we set up the included hosts, so they may understand how to do the rest themselves. Always ask the customer how many hosts are being connected and sell the host adder depending on the customer's technology skillset. Note that this service applies to the connectivity of Dell devices not 3rd party devices.

### Additional Deployment Services (ADT) – sold with or without PD/PDP

You can expand the scope of a ProDeploy engagement leveraging Additional Deployment Time (ADT). ADT covers additional tasks above the normal deliverables of the ProDeploy offers. ADT can also be used as a standalone service without ProDeploy.

SKUs are available for both Project Management and Technical Resource Expertise. SKUs are sold as blocks of four hours remote or eight hours onsite. The delivery team can help in scoping the number of hours required for additional tasks.

## Data Migration Services

Migrating data sets is no easy task. Our experts use proven tools and process to streamline data migrations and avoid compromising data. A customer project manager works with our experienced team of experts to create a migration plan. Data migration is part of every technology upgrade, platform change, and shift to the cloud. You can rely on Dell data migration services to perform a seamless transition.

## Residency Services

Certified technical professionals act like an extension of your IT staff to enhance internal capabilities and resources and help you realize faster adoption and maximized ROI of new technology. Residency Services help customers transition to new capabilities quickly by leveraging specific technology skill sets. Residency experts can provide post implementation management and knowledge transfer that is related to a new technology acquisition or day-to-day operational management of the IT infrastructure.

- Global experts available to serve in-person (onsite) or virtual (remote)
- Engagements starting at 2 weeks with flexibility to adjust
- Residency is available for project management needs, and many different technology skills sets such as: Server, storage, Gen AI, networking, security, multi-cloud, data mgmt., and modern workforce application residents

## Unique Deployment Scenarios

### Custom Deployment Services

When a deployment is beyond the scope of the ProDeploy Infrastructure Suite, you can turn to the custom deployment services team to address complex implementation scenarios and customer unique requirements. The Dell custom deployment team is staffed with solution architects who will assist with customer scoping calls to define the project and develop the statement of work. Custom services can handle a wide range of deployments that can be performed in the factory or onsite. All custom engagement services are requested through SFDC.

### Deployment of AI or HPC using Cluster Build Services


Once the integrated rack arrives the data center or is built onsite, Dell can also convert the racks into a large computing cluster. Dell provides several deploy options for Artificial Intelligence (AI) or High-Performance Computing (HPC) implementations. These complex environments require specialists that understand advanced feature sets to create a unified computing cluster for the most demanding workloads. Choose one of the cluster build add-ons below.

Increase Time to Value and with ProDeploy Flex and Cluster Builds

**Sell as Custom Quote or Standard SKUs**  
Add-ons 1 & 2 arriving as standard SKUs in Sept.

**ProDeploy Flex Rack Integration or ProDeploy Flex Onsite**

**+ Cluster Build Add-ons**  
Select one or more add-ons below



		Ideal for
1	<b>Physical Configuration of Cluster</b> <ul style="list-style-type: none"> <li>Onsite Infrastructure Assessment</li> <li>Installation of switches<sup>1</sup></li> <li>Inter-rack cabling and labeling</li> <li>Liquid connectivity and leak test<sup>2</sup></li> </ul>	Customers needing help with installing the network, inter-rack cabling, and fabric testing
2	<b>Logical Configuration of Cluster</b> <ul style="list-style-type: none"> <li>Review system design and plan</li> <li>Configure switches &amp; mgmt nodes</li> <li>Validation and acceptance testing</li> </ul>	Customers requiring cluster configuration and essential testing of the solution
3	<b>AI Network Design Services</b> <ul style="list-style-type: none"> <li>2-week intensive consultation that accelerates AI network performance and maximizes operational efficiency<sup>3</sup></li> </ul>	Customers seeking foundational design strategy to achieve optimal performance

When the environment is demanding, your configuration can't be average ★★★★★

**Key Benefits:**

- Factory rack integration enables faster time to value and reliability
- Reduce onsite setup time and fast track to production
- Fine-tuned system performance based on workload types
- Services aligned with enterprise-grade security standards
- Final testing and customer handoff lessen amount of support calls

1 -- Network switches to be installed in factory or onsite depending on requirements. Choose options: ProDeploy Flex Rack Integration or ProDeploy Flex Onsite combined with PD Flex Cluster Add-ons  
 2 -- If applicable. Leak test performed in factory and again onsite which is limited to in-rack CXK!  
 Secondary Fluid Network (SFN) design and deployment quoted separately by Vertiv or Mollnar.  
 3 -- AI Network Design Service is ordered as a Custom Service Engagement via SFDC or SFP

Figure 47. Deployment choices for cluster implementation

## DAY 2 – Automation Services with Ansible

Dell solutions are built as “automation ready” with integrated APIs (Application Programming Interfaces) to allow customers to programmatically call actions on the product through code. Although Dell has published Ansible automation use cases, some customers need additional assistance with GitOps. By the end of the service, the customer will have the foundational components required to accelerate automation and understand how the programming works together: Day 1 and Day 2 use case automation scripts (ansible modules), CI/CD tool (Jenkins), and Version control (Git).

## Dell Technologies Consulting Services

Our expert consultants help customers transform faster, and quickly achieve business outcomes for the high-value workloads Dell PowerEdge systems can handle. From strategy to full-scale implementation, Dell Technologies Consulting can help determine how to perform IT, workforce, or application transformation. We use prescriptive approaches and proven methodologies that are combined with the portfolio and partner ecosystem of Dell Technologies to help achieve real business outcomes. From multicloud, applications, DevOps, and infrastructure transformations, to business resiliency, data center modernization, analytics, workforce collaboration, and user experiences—we are here to help.

### Dell Managed Services

Some customers prefer Dell to manage the complexity and risk of daily IT operations, Dell Managed Services utilizes proactive, AI enabled delivery operations and modern automation to help customers realize desired business outcomes from their infrastructure investments. With these technologies, our experts run, update, and fine-tune customer environments that are aligned with service levels, while providing environment-wide and down-to-the-device visibility. There are two types of managed service offers. First the outsourcing model or CAPEX model where Dell manages the customer owned assets using our people and tools. The second is the as-a-Service model or OPEX model called APEX. In this service, Dell owns all technology and all the management of it. Many customers will have a blend of the two management types depending on the goals of the organization.



Figure 48. Dell Managed Services

## Cyber-Security Services

### Managed Detection and Response (MDR)

Dell Managed Detection and Response Pro Plus is our fully-managed, 360° security operations solution comprised of our most cutting-edge, preventive and responsive cybersecurity services. MDR Pro Plus was designed with your top security concerns in mind, allowing you to focus on your core business goals while Dell handles your security operations. First, we have Vulnerability Management. With this service, we'll do ongoing scanning of the customer's environment looking for software that needs to be patched. Next is Pen Testing and Attack Simulation Management. This service will continuously validate security controls and policies with automated Breach and Attack Simulation (BAS), because a misconfiguration can lead to an exposure which an attacker can exploit. The service also includes an annual penetration test to determine if a skilled threat actor could exploit pathways leading to critical assets or data. Third, Managed Security Awareness Training. This service will educate the customer's end users so that they don't inadvertently put the customer at risk. If you think about our annual compliance training modules, there is always a security module. This is the same type of thing, but rather than once a year, it will be smaller, bite-size pieces of content delivered throughout the year. Fourth is our Managed Detection and Response service which provides 24x7 threat detection and investigation, analysis of end-to-end activity by threat actors, threat hunting, and quick initiation of cyber incident response when needed. Customers can choose between Secureworks Taegis XDR, CrowdStrike Falcon XDR or Microsoft Defender XDR as the security analytics platform our analysts will use to monitor their environment. All four of these services are delivered by experienced, certified Dell security experts using advanced technology such as the Secureworks Taegis XDR, CrowdStrike Falcon XDR or Microsoft Defender XDR security platforms.

## Dell Technologies Education Services

Build the IT skills required to influence the transformational outcomes of the business. Enable talent and empower teams with the right skills to lead and perform transformational strategy that drives competitive advantage. Leverage the training and certification that is required for real transformation.

Dell Technologies Education Services offers PowerEdge server training and certifications that are designed to help customers achieve more from their hardware investment. The curriculum delivers the information and the practical, firsthand skills that their team must confidently install, configure, manage, and troubleshoot Dell servers.

To learn more or register for a class today, see [Education.Dell.com](https://www.dell.com/education).

## Resources

[Service for powerEdge](#)